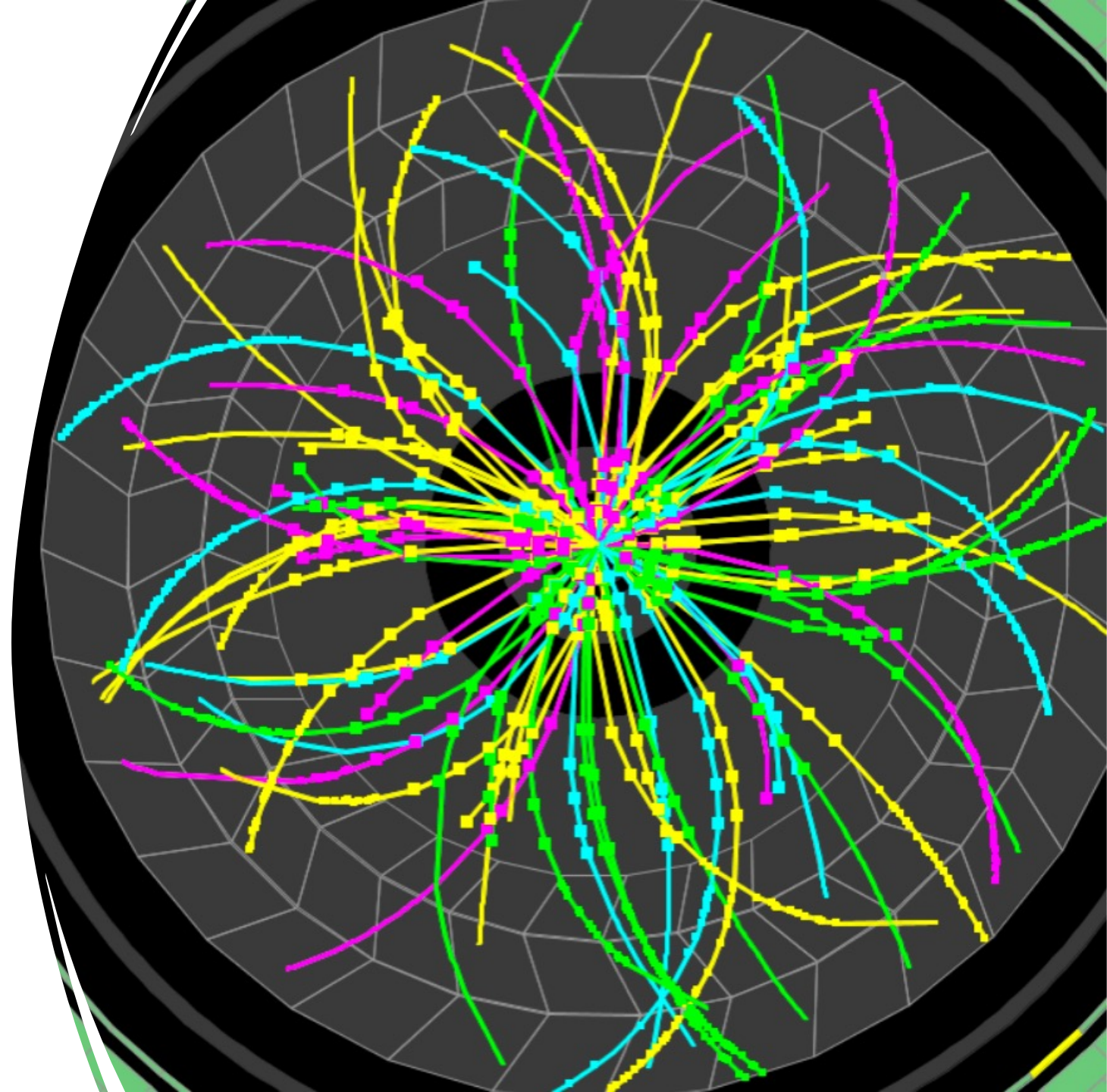


EicC Tracking System

*Aiqiang Guo, Yuming Ma,
Yutie Liang, Yuxiang Zhao
Chengxin Zhao, Yaping Wang
Yifei Zhang, Shuai Yang*
IMP, CCNU, USTC, SCNU

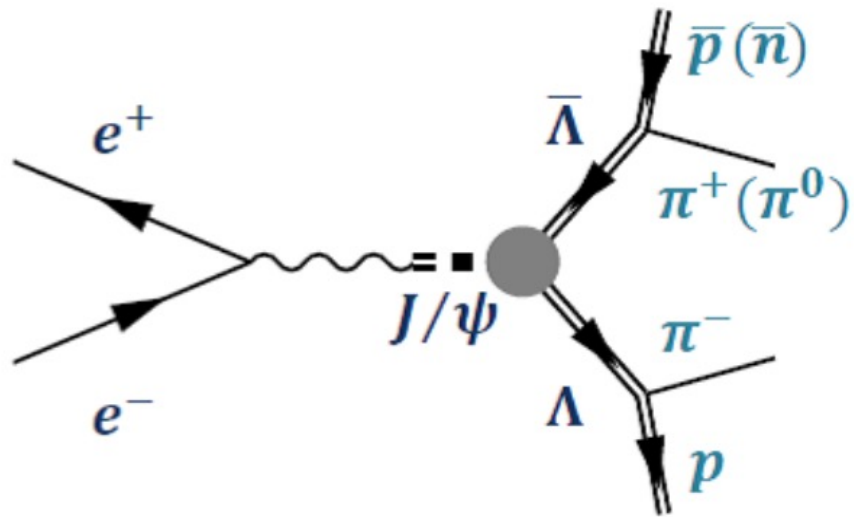


The 6th EicC CDR workshop - Huizhou



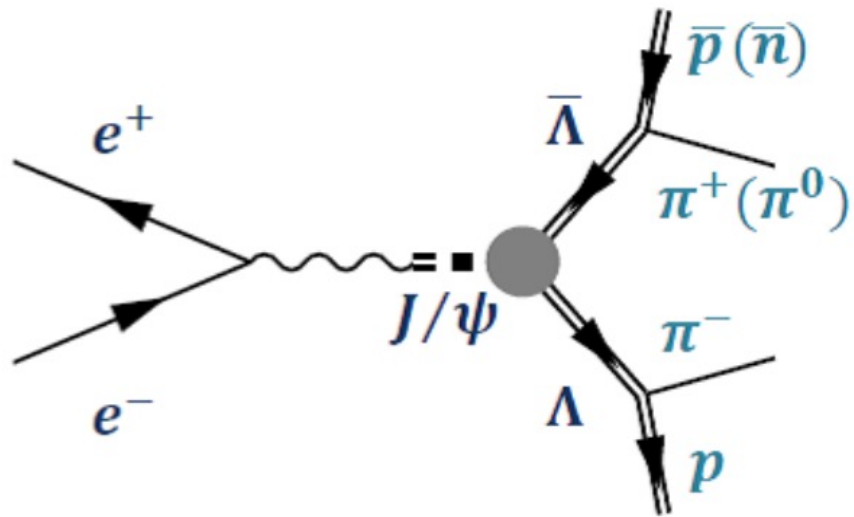
Introduction of tracking system

To study a physics process

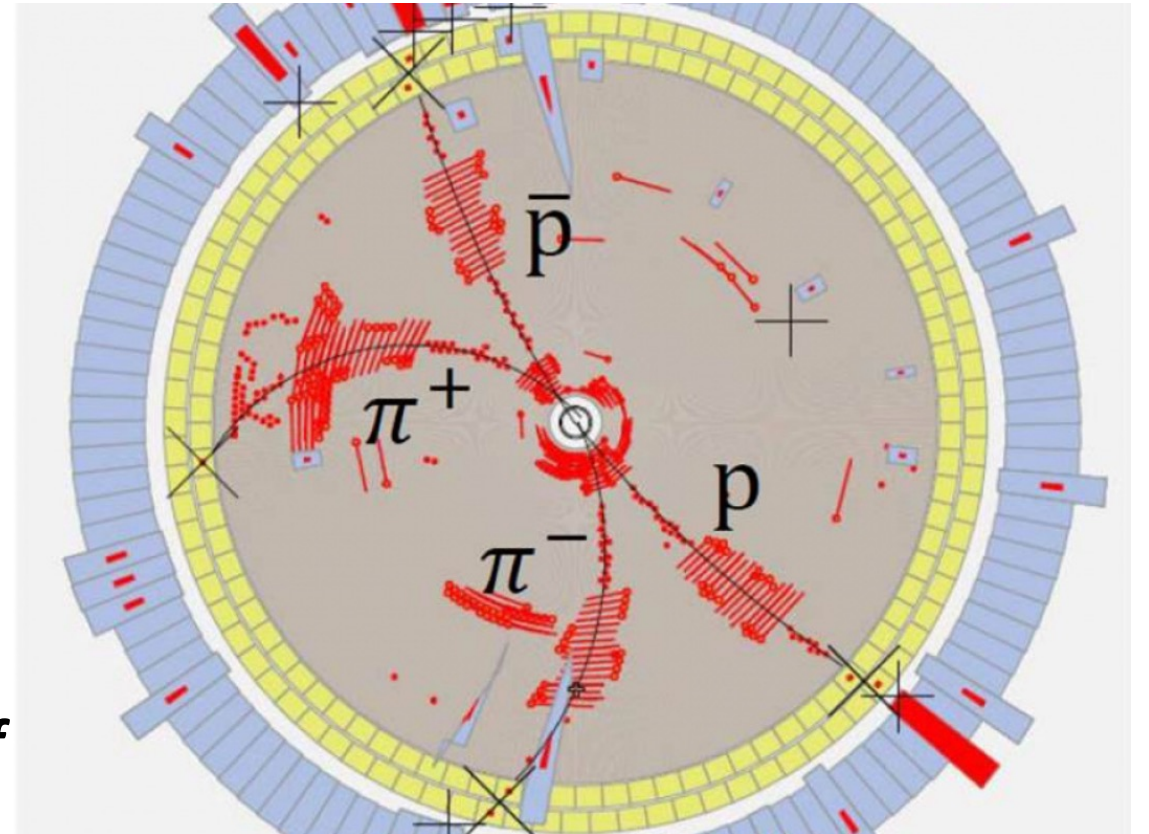


Introduction of tracking system

To study a physics process



Tracking is all about building an image of the particle interactions with detector

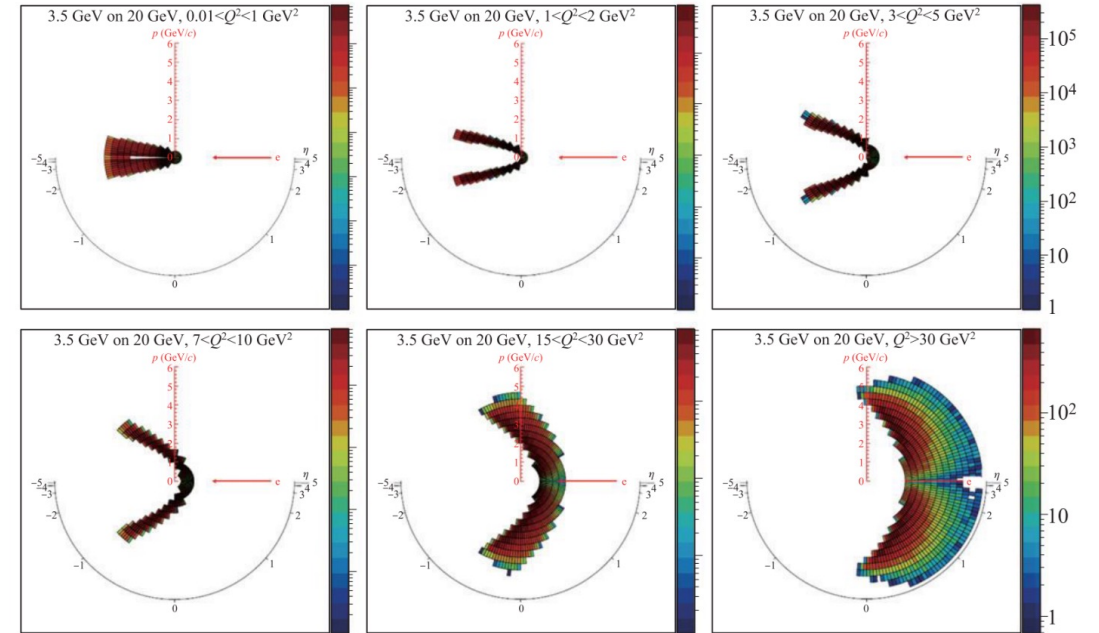
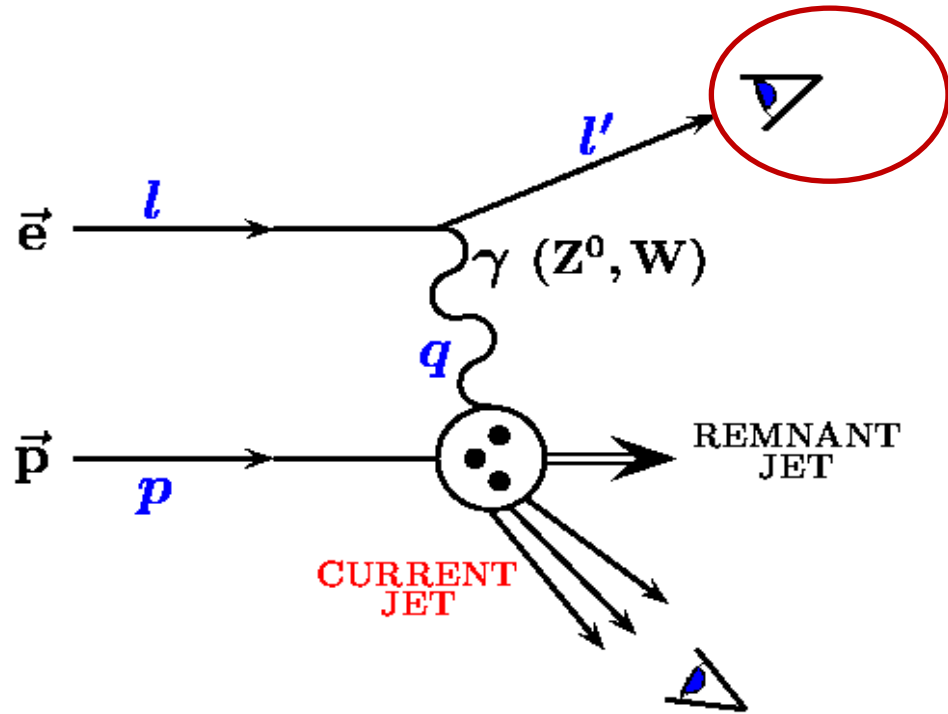


The talk will last about half an hour...

Requirements

The primary physics topic is spin physics, we need to explore the DIS, SIDIS, DVCS etc.

- the scattered electrons provide crucial information to most of processes

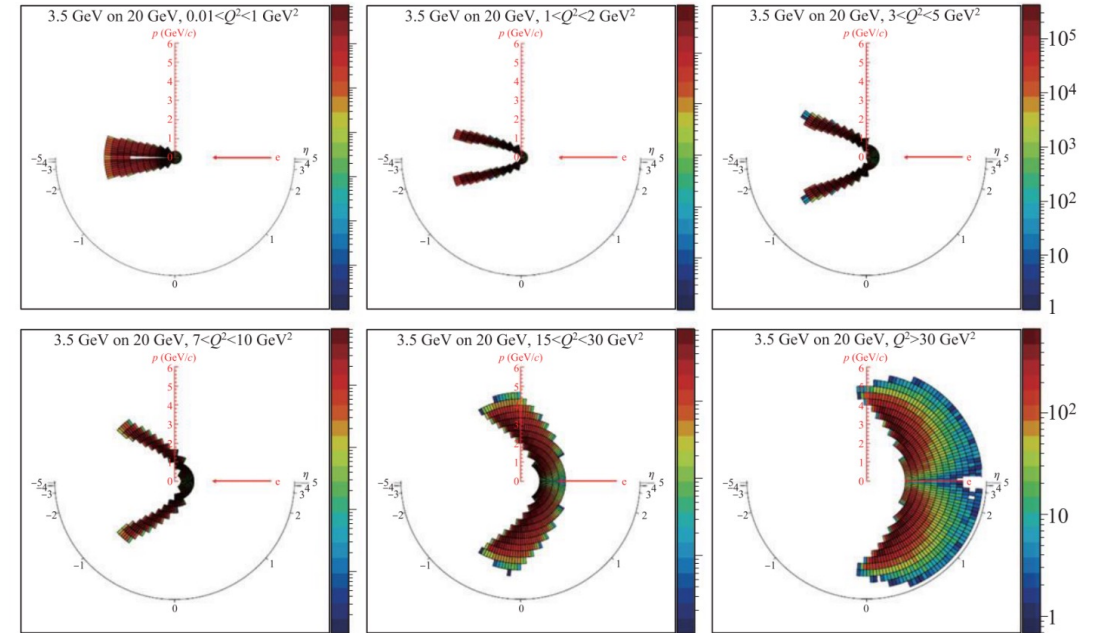
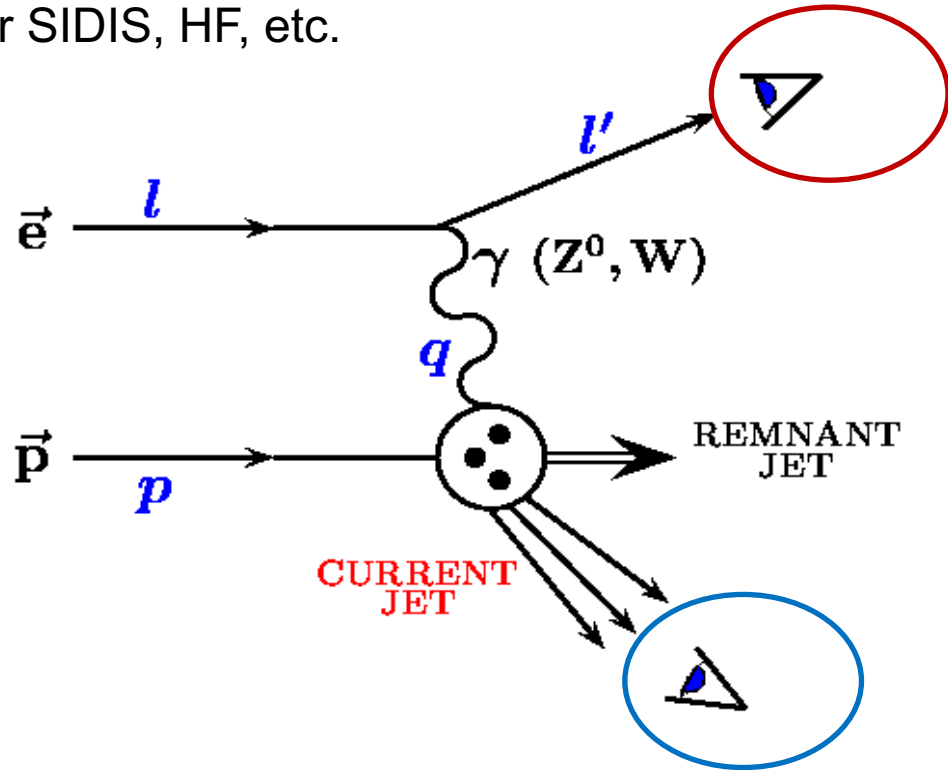


Kinematics of the scattered electron at various Q^2

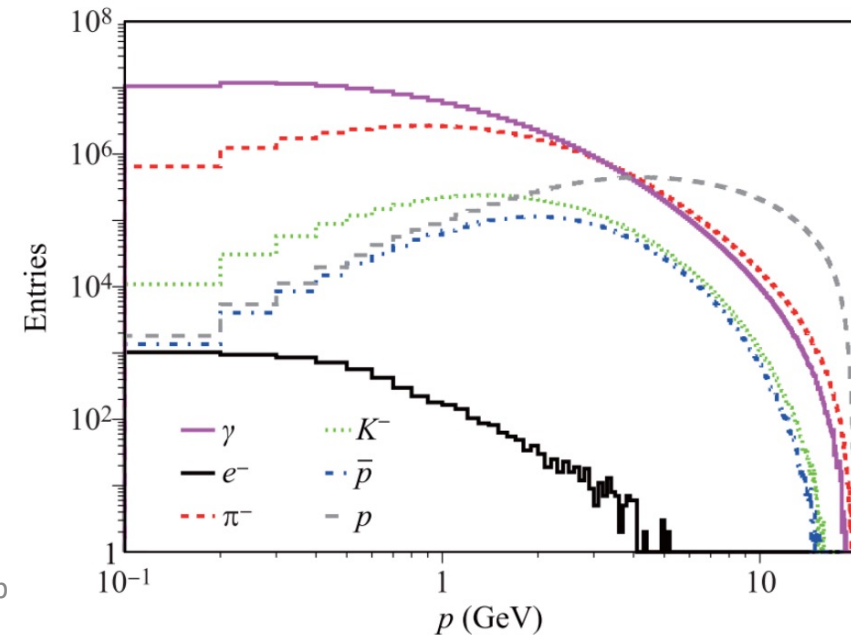
Requirements

The primary physics topic is spin physics, we need to explore the DIS, SIDIS, DVCS etc.

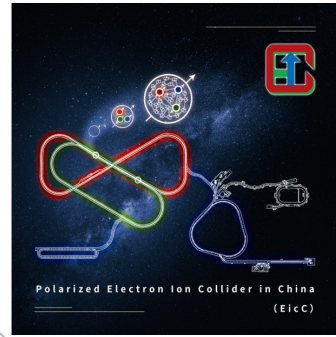
- the scattered electrons provide crucial information to most of processes
- The hadrons in the final states are essential for SIDIS, HF, etc.



Kinematics of the scattered electron at various Q^2

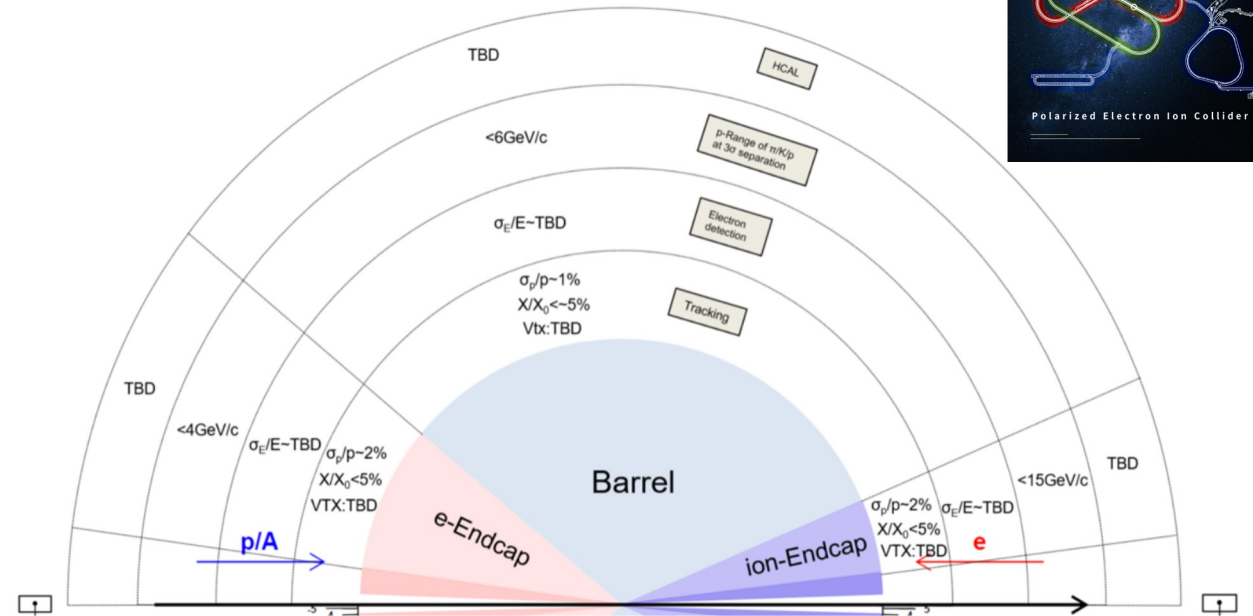


Requirements

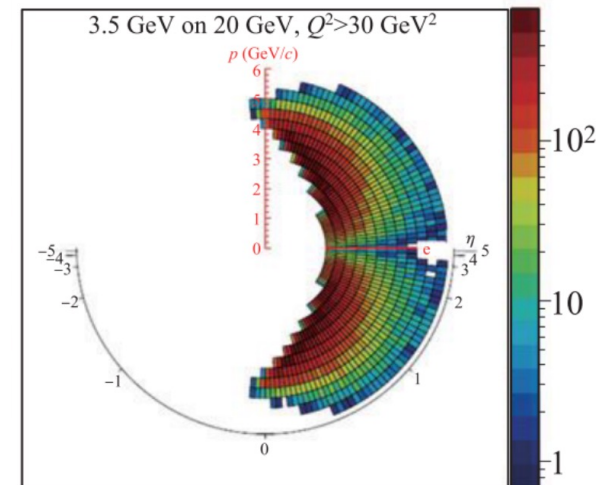


The primary physics topic is spin physics, we need to explore the DIS, SIDIS, DVCS etc.

- the scattered electrons provide crucial information to most of processes
- The hadrons in the final states are essential for SIDIS, HF, etc.
- A rough requirement is set →
- More efforts are needed to draw a **crystally clear conclusion !**



Region	η	δp	δDCA	Material Budget (X/X_0)	Physics Program
Barrel	[-1,0]	<1%	Cell 2,4	<5%	Exotics, etc.
	[0,1]	<1%	Cell 3,4	<5%	Cell 3,6
Ion-going	[1,2]	<2%	Cell 4,4	<5%	Gluon PDF, etc.
	[2,3.5]	<5%	Cell 5,4	<5%	Cell 5,6
Electron-going	[-1,-2]	<2%	Cell 6,4	<5%	Cell 6,6
	[-2,-3.5]	<5%	Cell 7,4	<5%	DIS, etc.



The momentum resolution

The momentum of a charged track is determined by its trajectory (curvature)

- The formula: $p = 0.3 RB$, R is the radius of the track, B is the intensity of the magnetic field
- Practically, we measure the sagitta to determine the R:

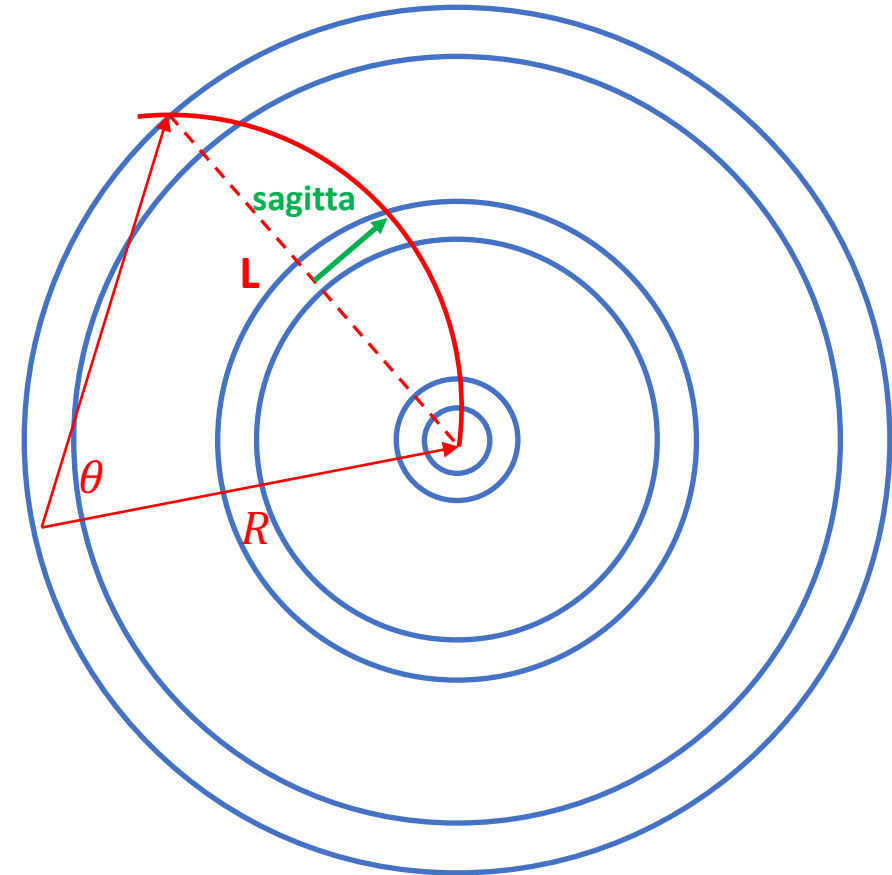
$$s = R \left(1 - \cos \frac{\theta}{2} \right) = 0.3BL^2/8p$$

- The relative momentum resolution is:

$$\frac{\sigma_p}{p} = \frac{\sigma_s}{s} = \frac{8p}{0.3BL^2} \sigma_s$$

To improve the momentum resolution:

- Reduce σ_s :
 - **Reduce Multiple-scattering effect**
 - **Better detector spatial resolution**
- Increase intensity of B field. Downside \rightarrow lower tracking efficiency (low p)
- **Increase scale of detector L**. Downside \rightarrow higher cost
- The momentum resolution is proportional to p

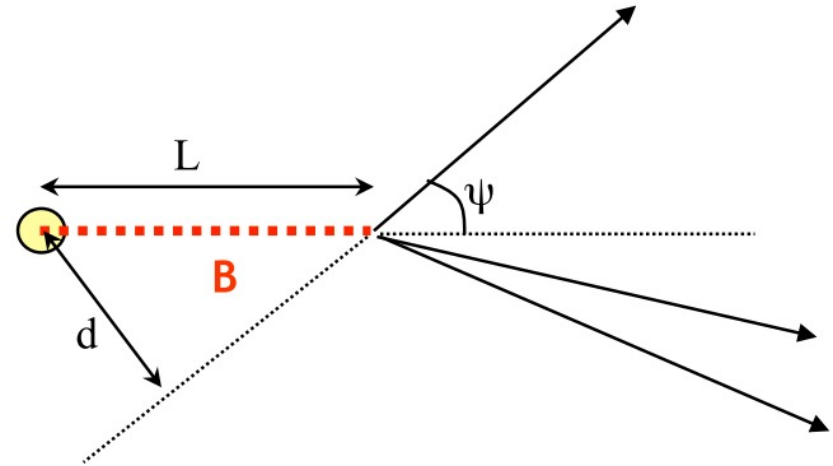


Vertex resolution

The impact parameter d :

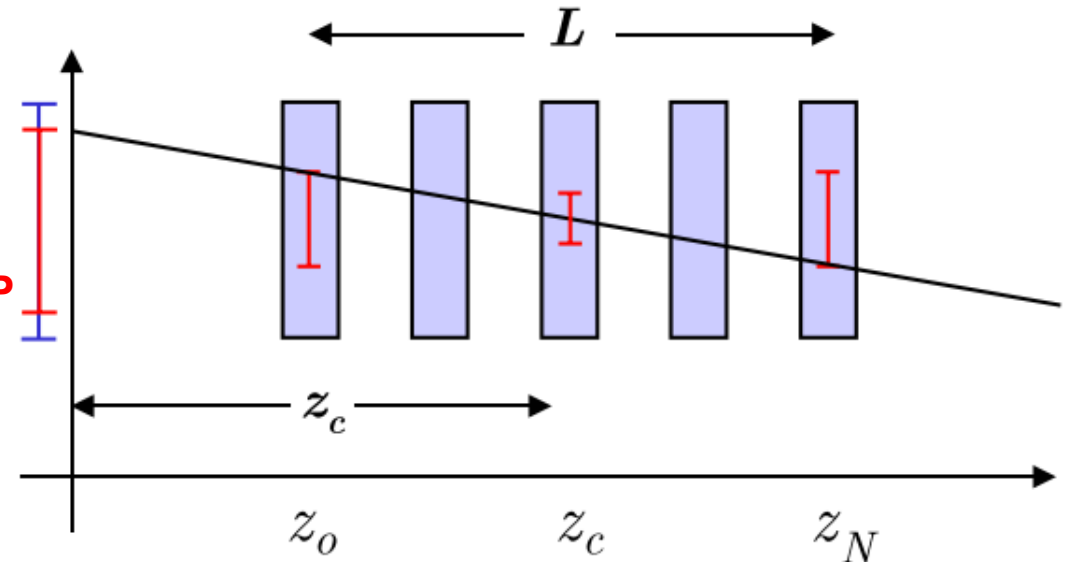
- $d = L \sin \psi$
- ψ is due to multiple-scattering and detector resolution
- In the case of equal spacing detector and equal errors σ
- The uncertainty of measurement on vertex (details in backup):

$$\sigma_{vertex}^2 = \frac{\sigma^2}{N+1} + \frac{\sigma^2}{N+1} \frac{12N}{N+2} \frac{Z_c^2}{L^2}$$



To improve the vertex resolution:

- Reduce σ :
 - **Reduce Multiple-scattering effect**
 - **Better detector spatial resolution**
- **Increase scale of detector L.**
- **Reduce Z_c : Place the first plane as near as possible to the IP**
- Increase the number of points, only as $\sqrt{N+1}$

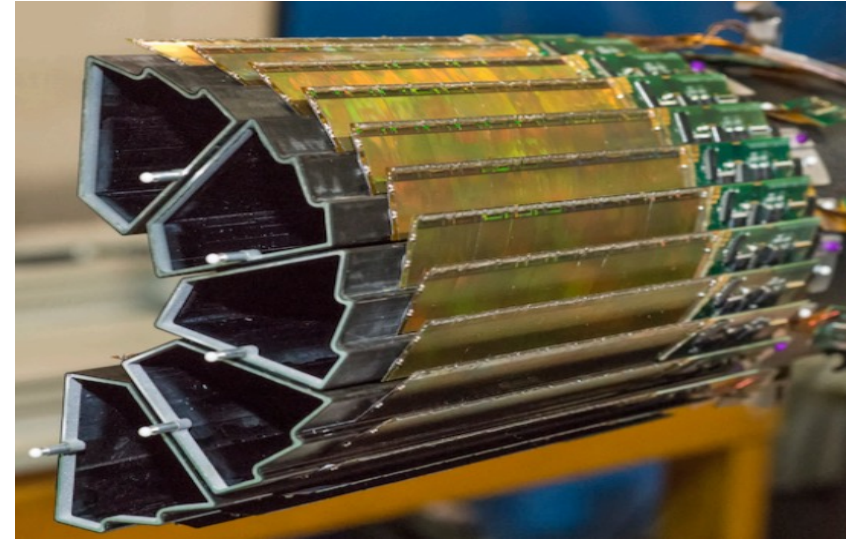
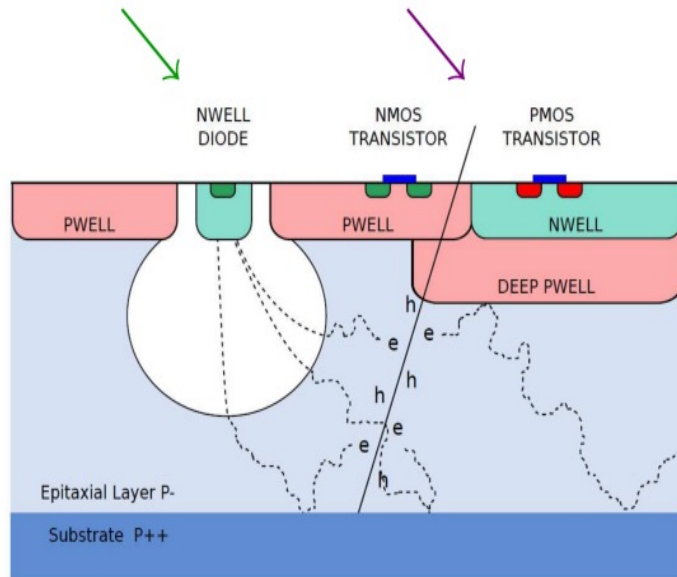


Technologies

- **Vertex + inner tracker**
 - Excellent spatial resolution
 - Low material
 - Radiation hardness

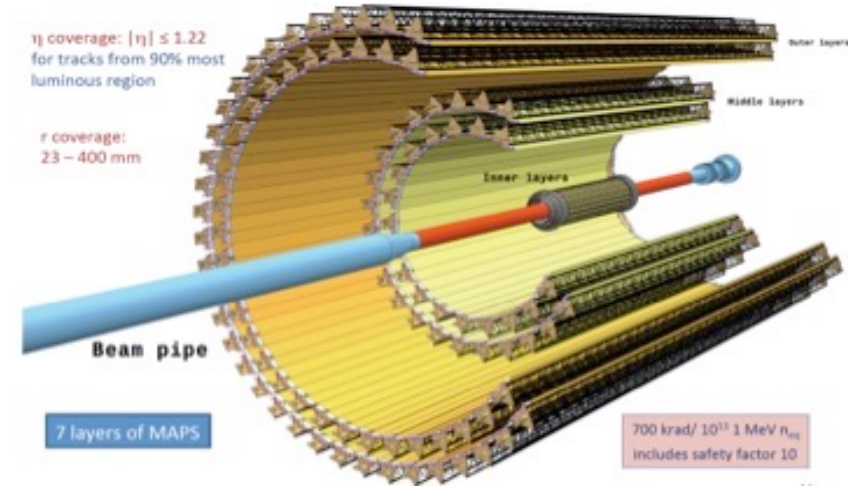
The Monolithic Active Pixel Sensor (MAPS)

- CMOS Pixel Sensors \equiv **Detector** \oplus **Front-End Electronics** in same die



STAR HFT (世界上首个像素探测器)

400片MAPS, 360M pixels



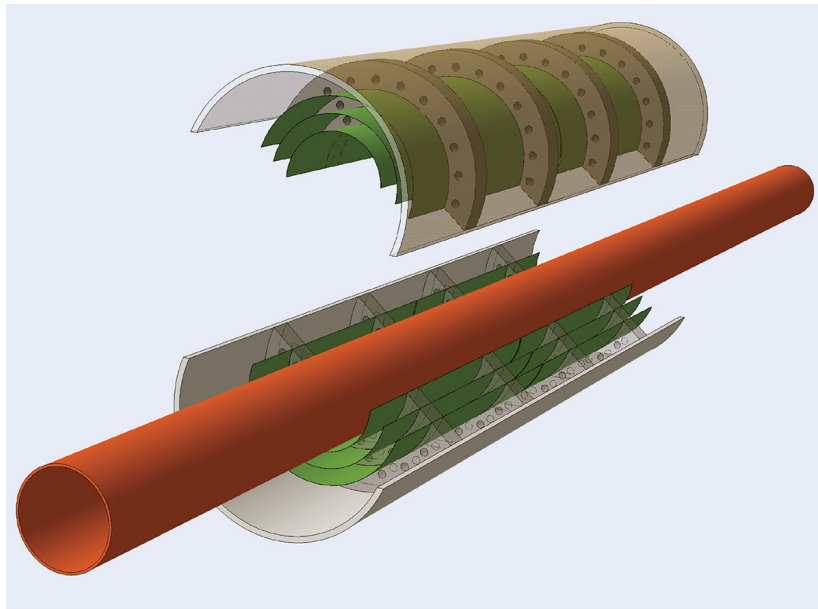
ALICE ITS 探测器 (目前最大规模像素探测器)

24142块MAPS, $\sim 10\text{m}^2$, 12.5G pixels

Technologies

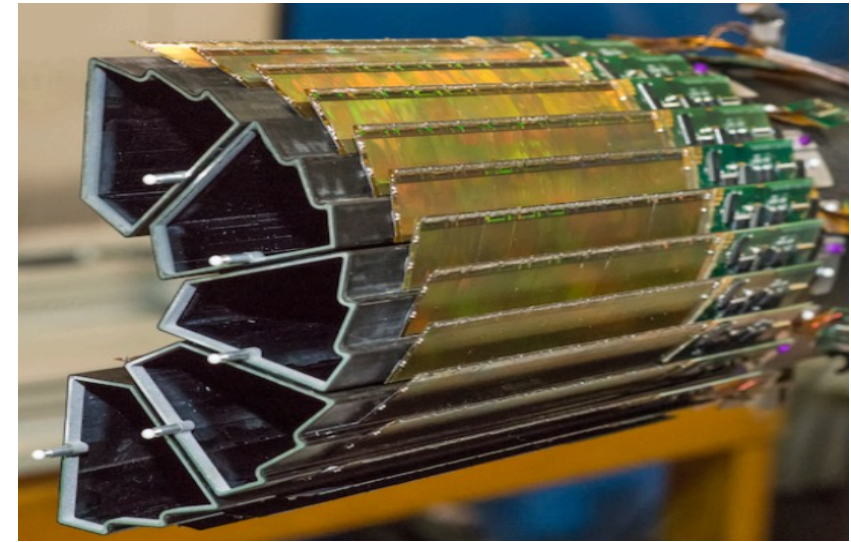
- **Vertex + inner tracker**
 - Excellent spatial resolution
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The Monolithic Active Pixel Sensor (MAPS)

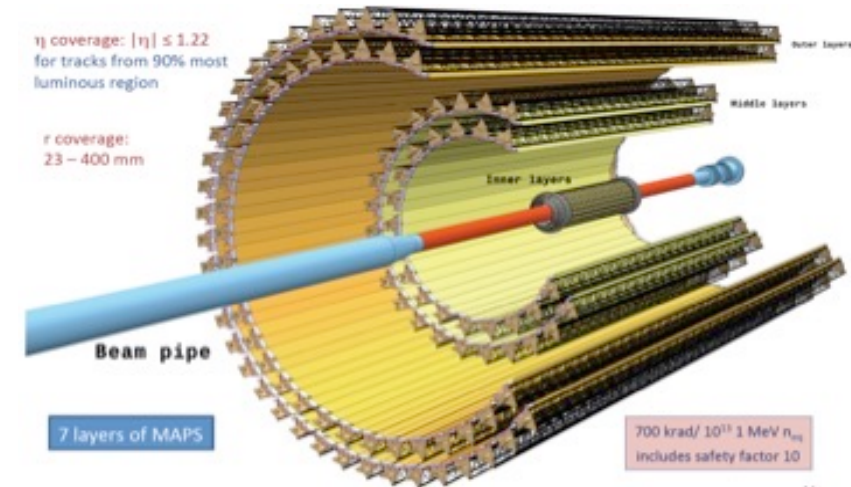


ITS3 (MIC7)
Pixel size: $10 \mu\text{m}$
Material: $0.05\% X/X_0$

EicC CDR Workshop



STAR HFT (世界上首个像素探测器)
400片MAPS, 360M pixels



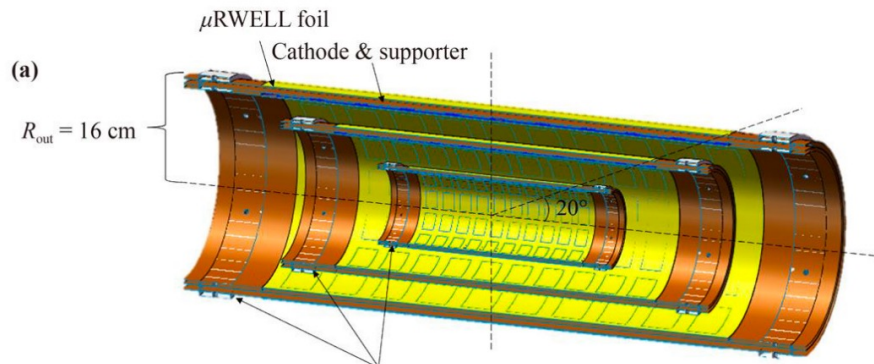
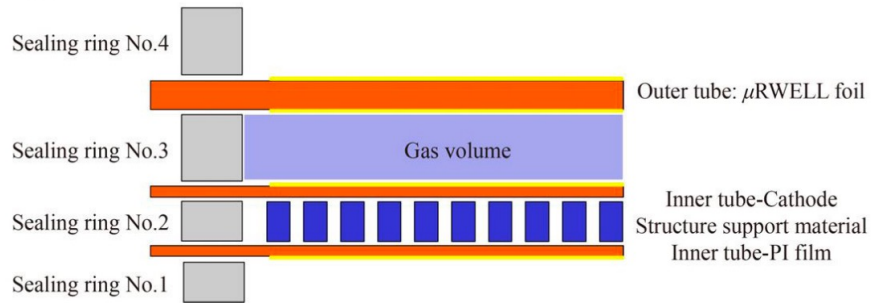
ALICE ITS 探测器 (目前最大规模像素探测器)
24142块MAPS, $\sim 10\text{m}^2$, 12.5G pixels

Technologies

- **Outer tracker**

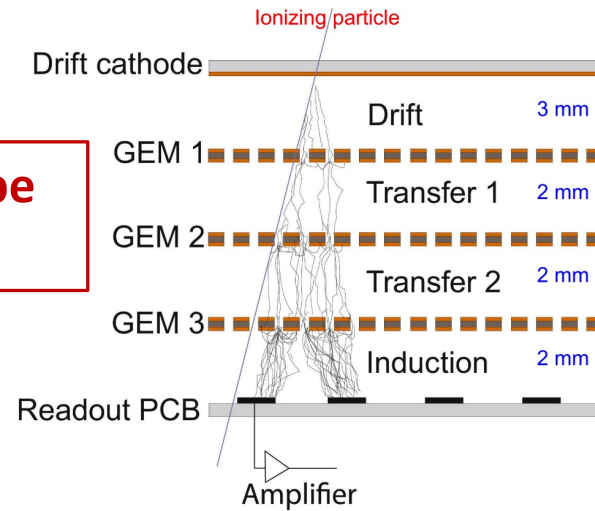
- Large area
- Good spatial resolution

More details can be found in YP's Talk

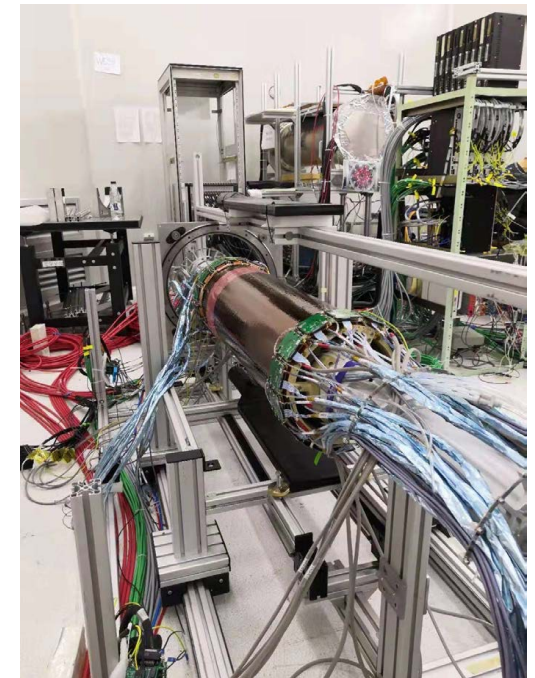


3 layers of cylindrical μ RWELL inner tracker (with sensitive length of 33, 61, 88 cm, respectively)

μ RWELL for STCF

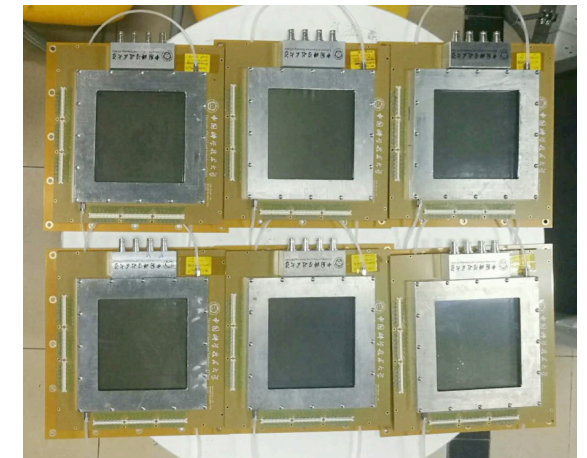


Gas Electron Multiplier (GEM)



CGEM for BESIII

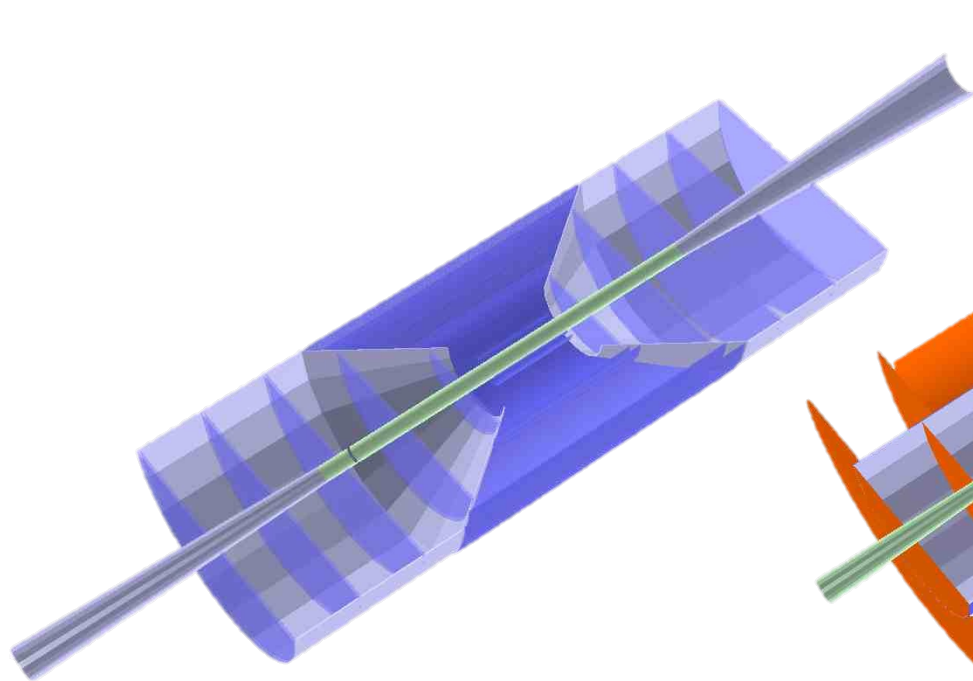
Micromegas
EicC CDR Workshop



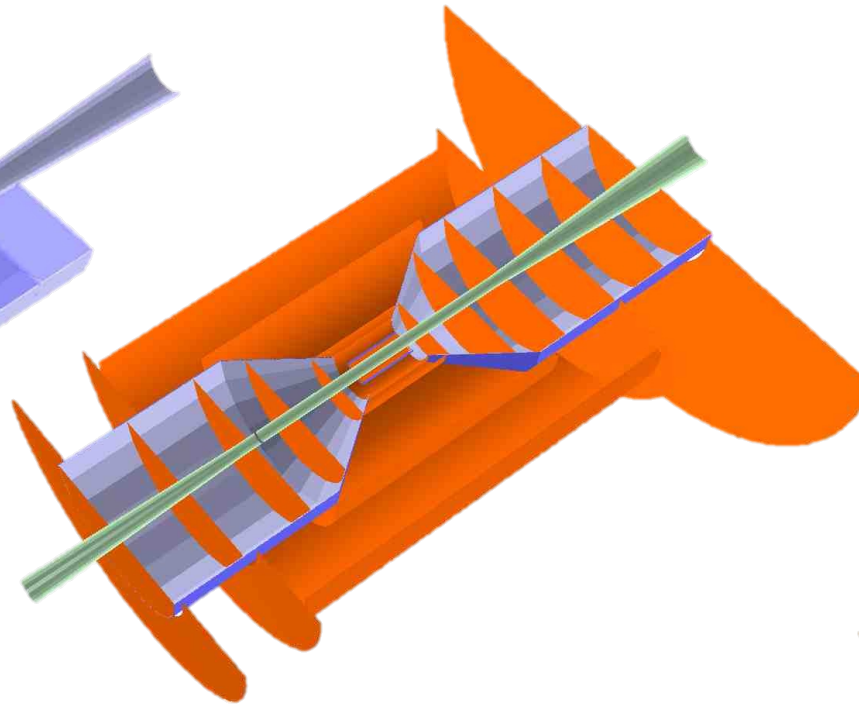
25cm x 25 cm Micromegas

The evolution of the EicC tracker design

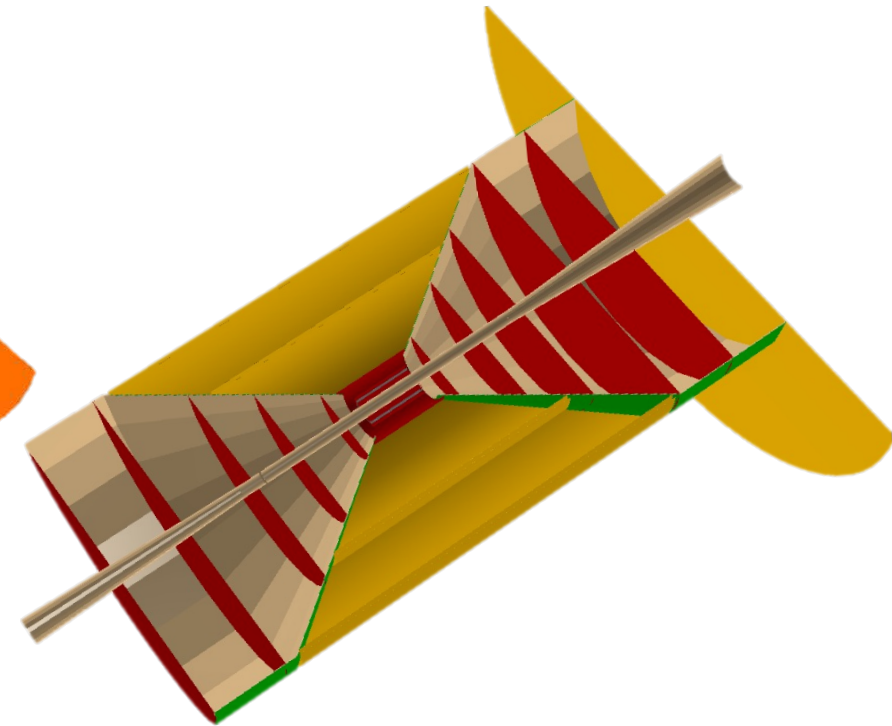
Det_v0



Det_v1/2



Det_v3



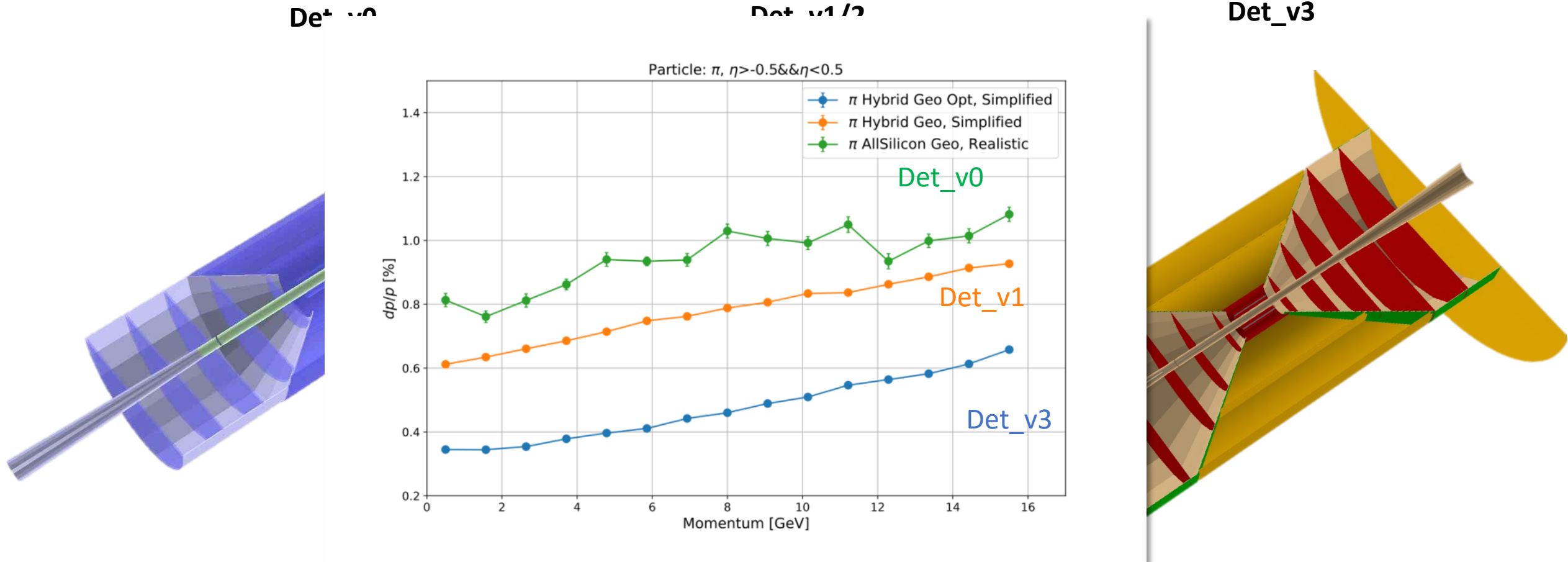
- All-silicon based on ITS2

- Silicon+MPGD Hybrid design
- Silicon: vertex ITS3 + tracker ITS2
- Only the pixel size is different for v1/v2

EicC CDR Workshop

- Silicon+MPGD Hybrid design
- Silicon: ITS3
- Geometry is Optimized

The evolution of the EicC tracker design



➤ All-silicon based on ITS2

➤ Silicon+MPGD Hybrid design

➤ Silicon+MPGD Hybrid design

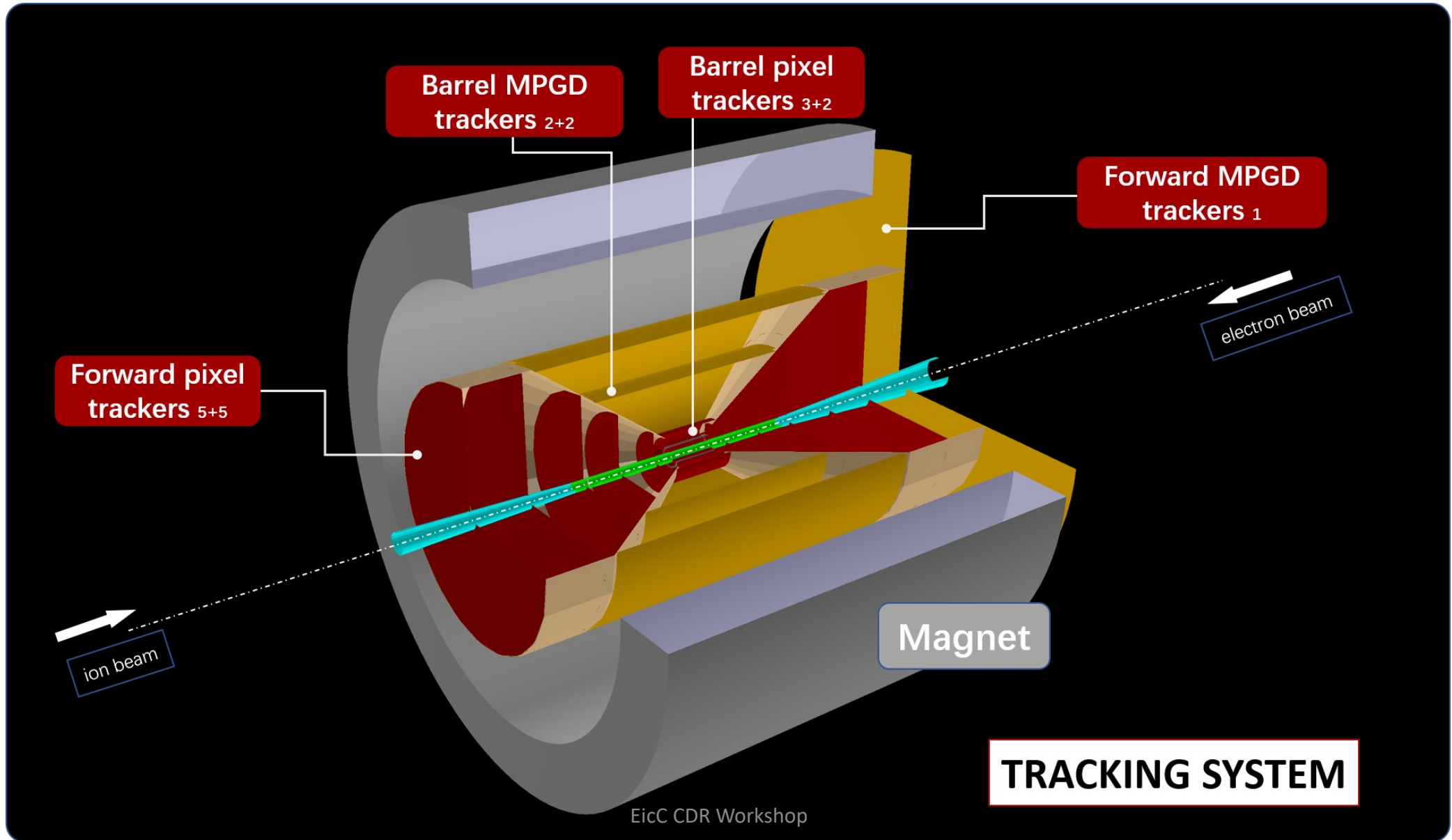
➤ Silicon: vertex ITS3 + tracker ITS2

➤ Silicon: ITS3

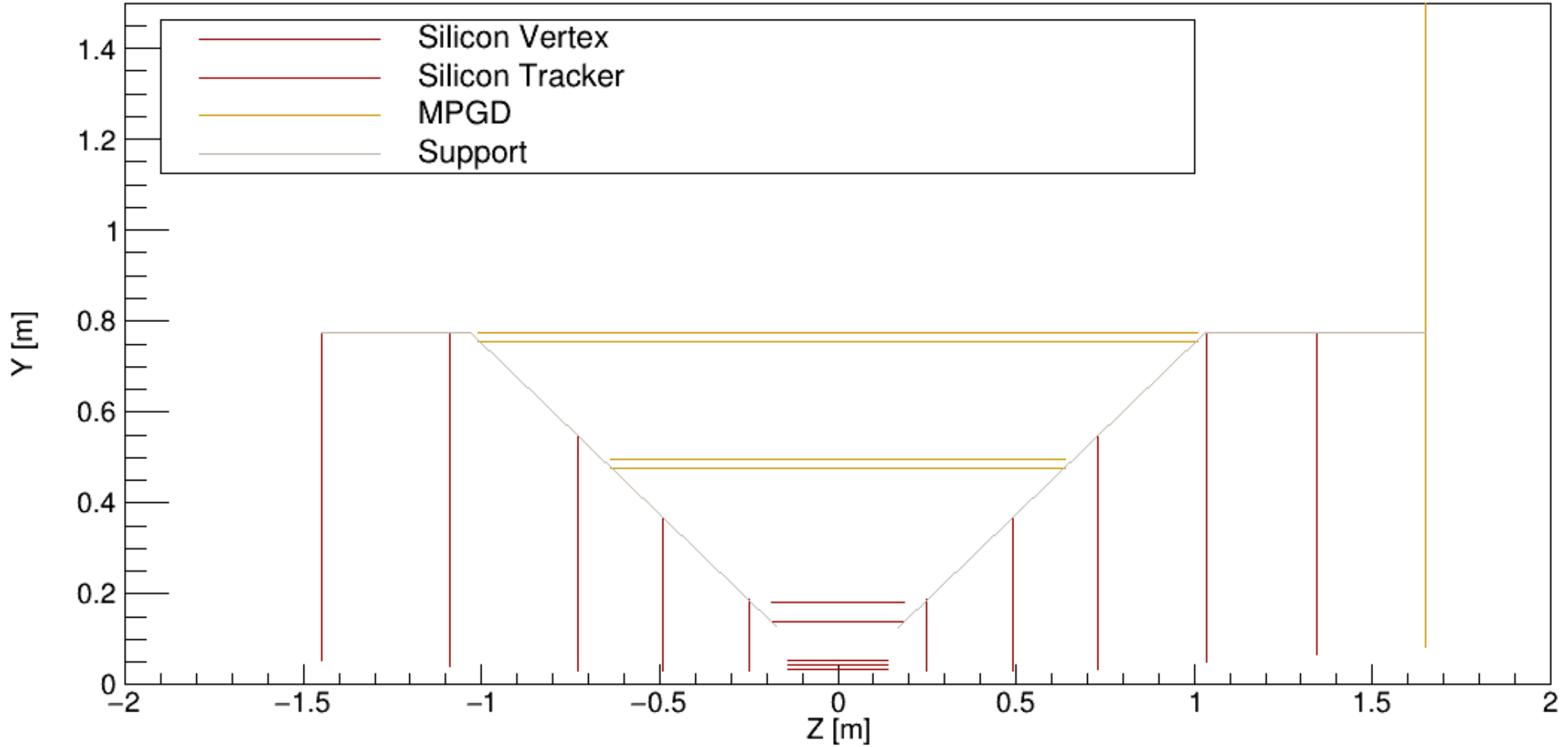
➤ Only the pixel size is different for v1/v2

➤ Geometry is Optimized

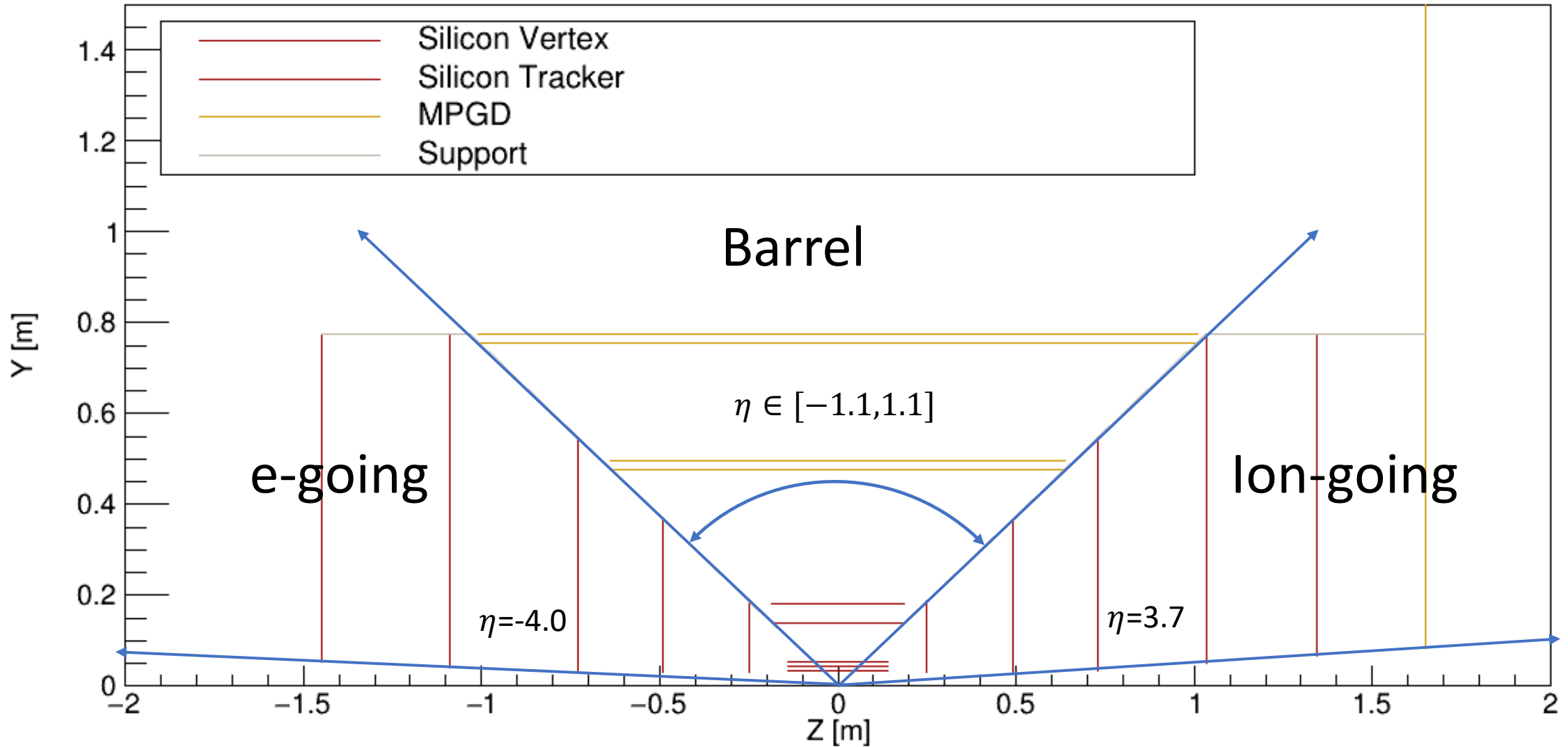
The latest design



The latest design

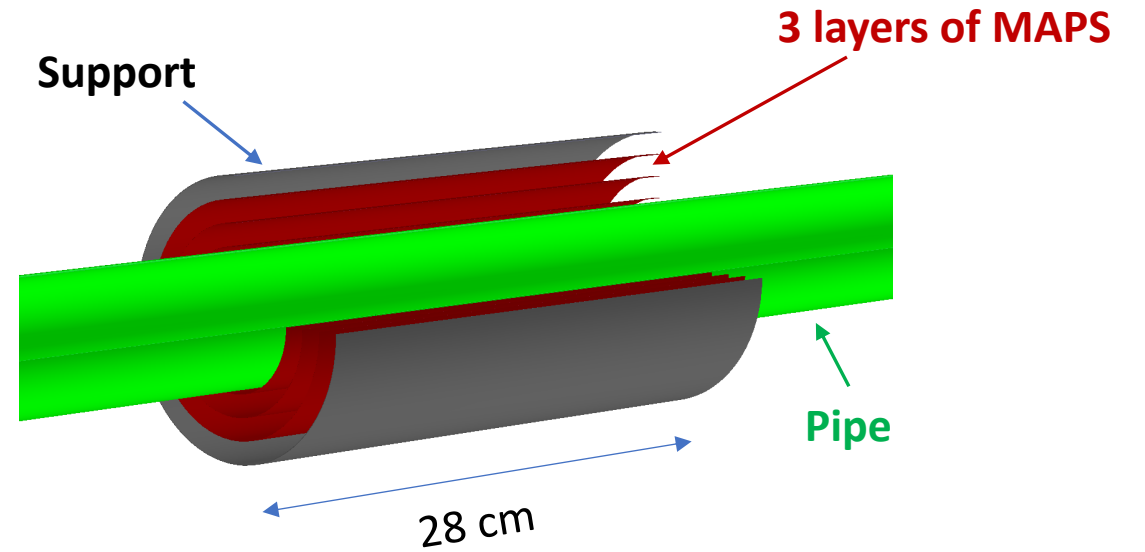
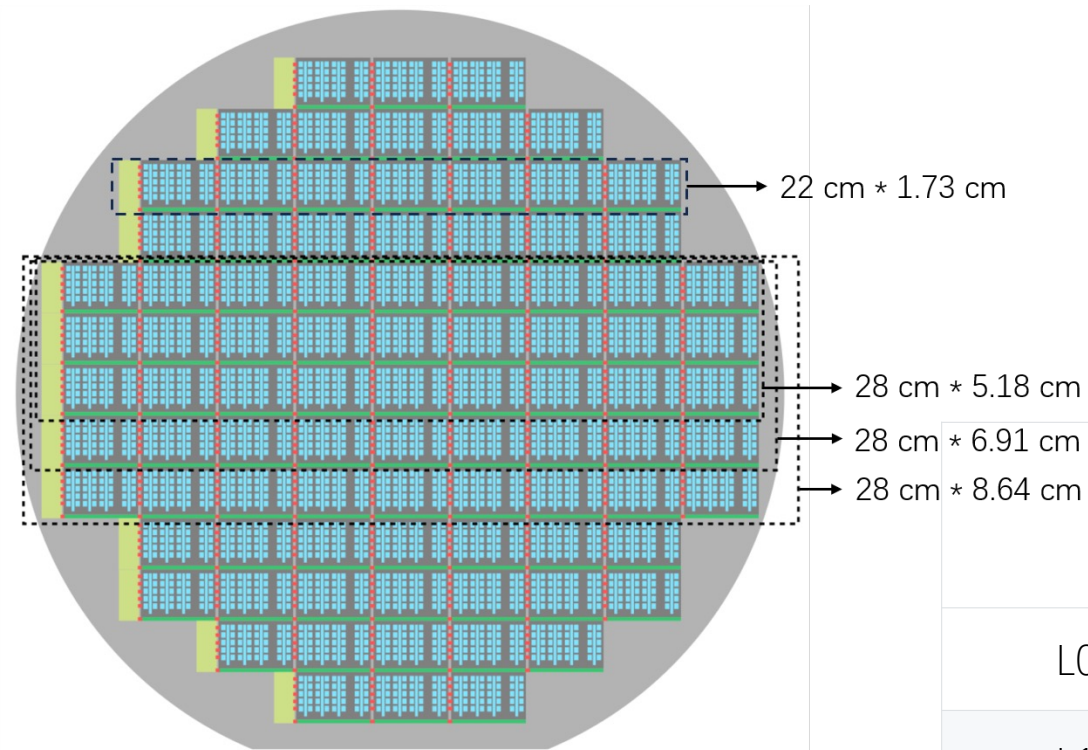


The latest design



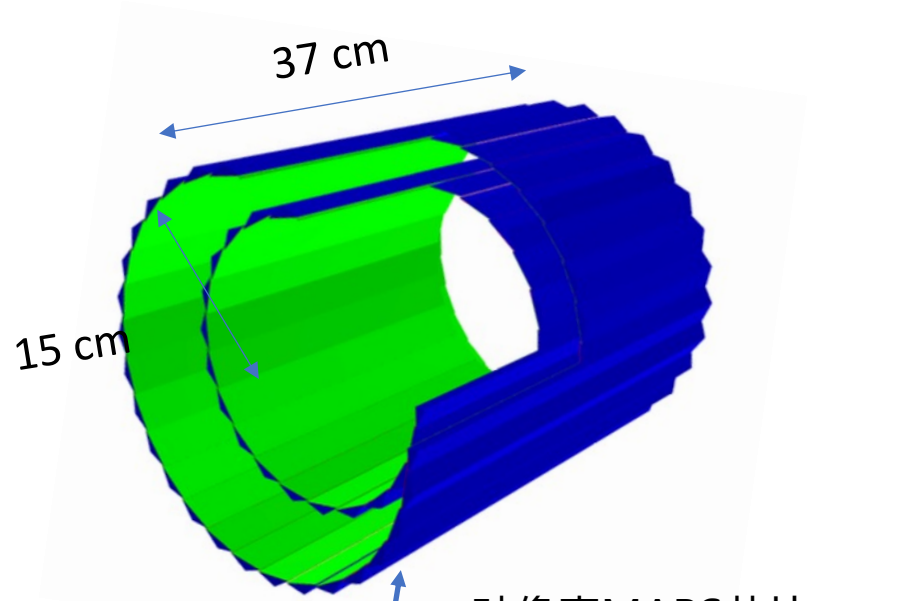
Barrel: Vertex

ITS3-based Vertex Detector

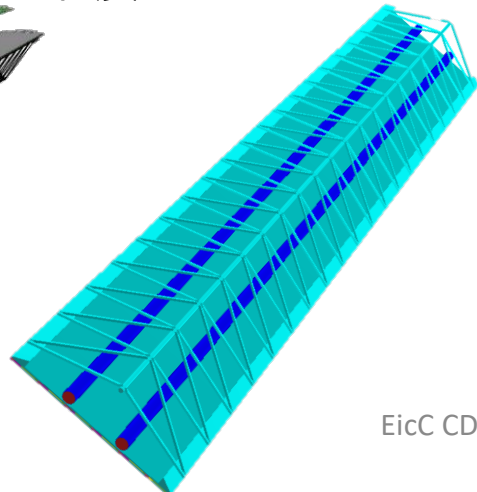
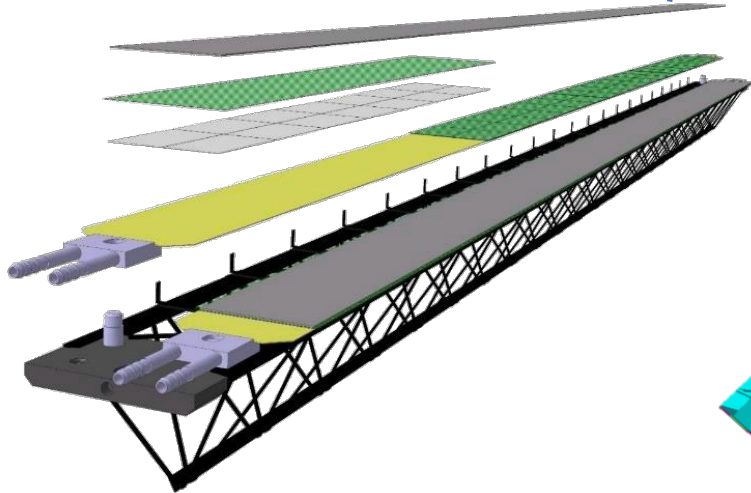


	R(cm)	Length(cm)	Pitch Size(μm)	Material Budget (X/X0 %)	Tech
L0	3.30	28.0	10	0.05	ITS3
L1	4.40	28.0	10	0.05	ITS3
L2	5.50	28.0	10	0.05	ITS3

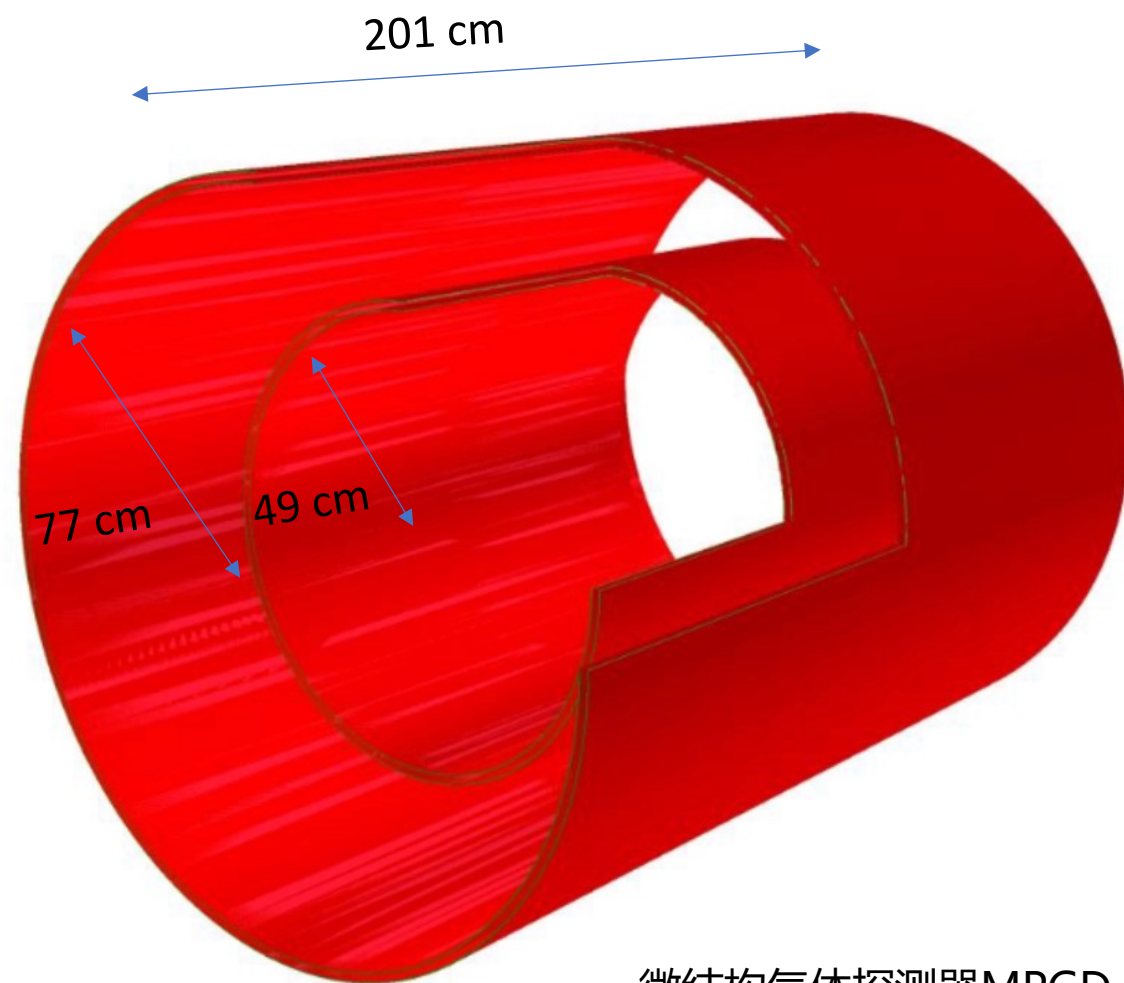
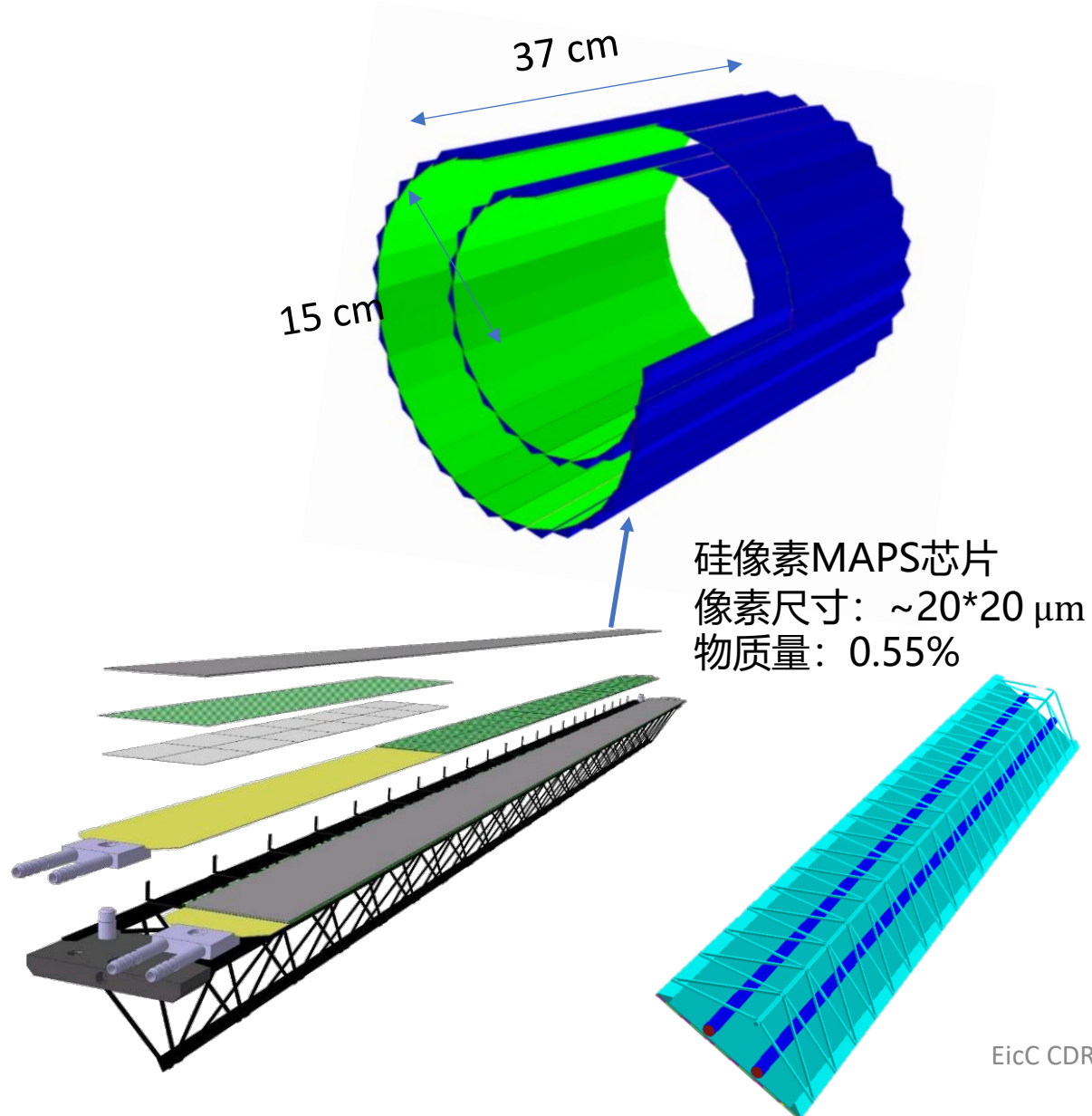
Barrel: Outer tracker



硅像素MAPS芯片
像素尺寸: $\sim 20 \times 20 \mu\text{m}$
物质质量: 0.55%

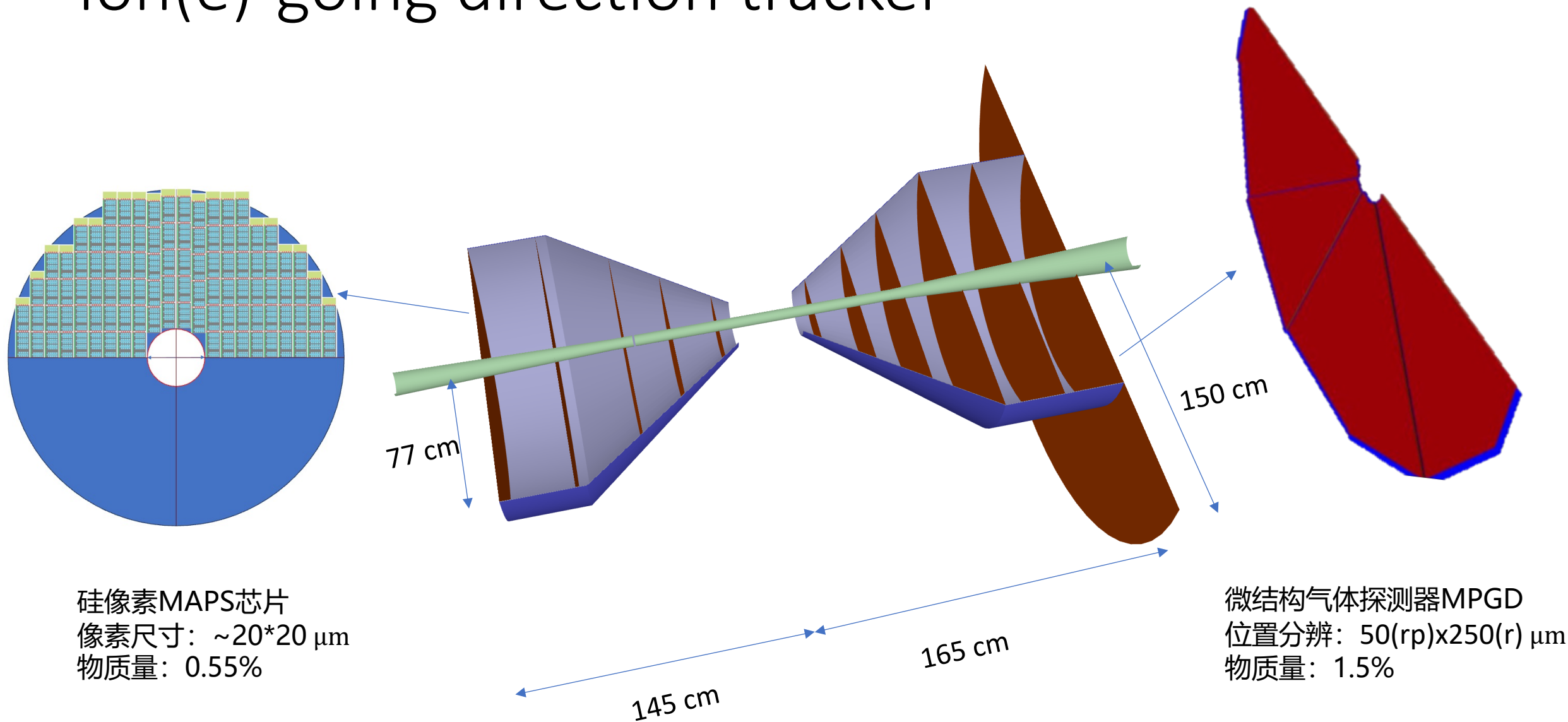


Barrel: Outer tracker

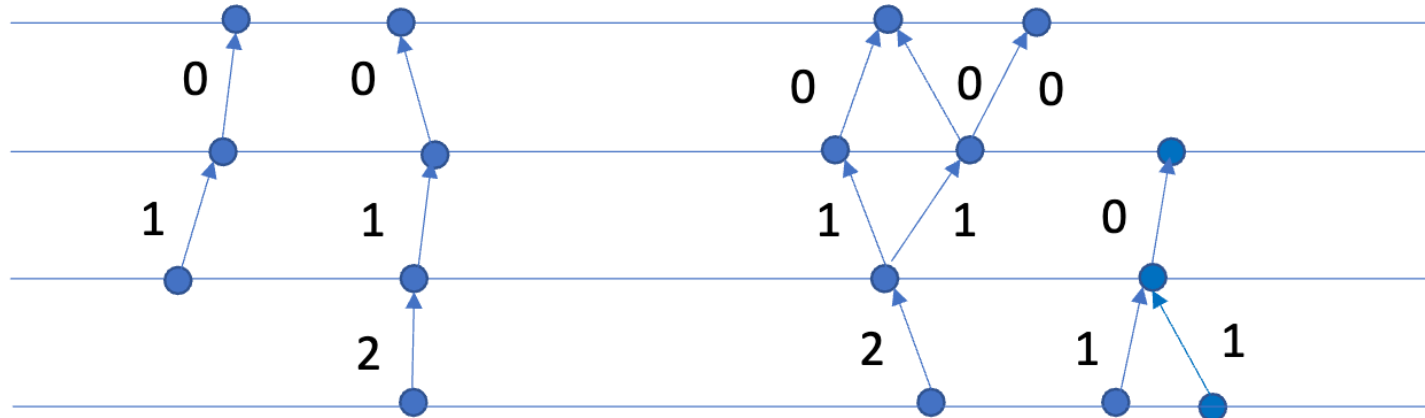


微结构气体探测器MPGD
位置分辨: $\sim 150 \mu\text{m}$
物质质量: $< 1.5\%$

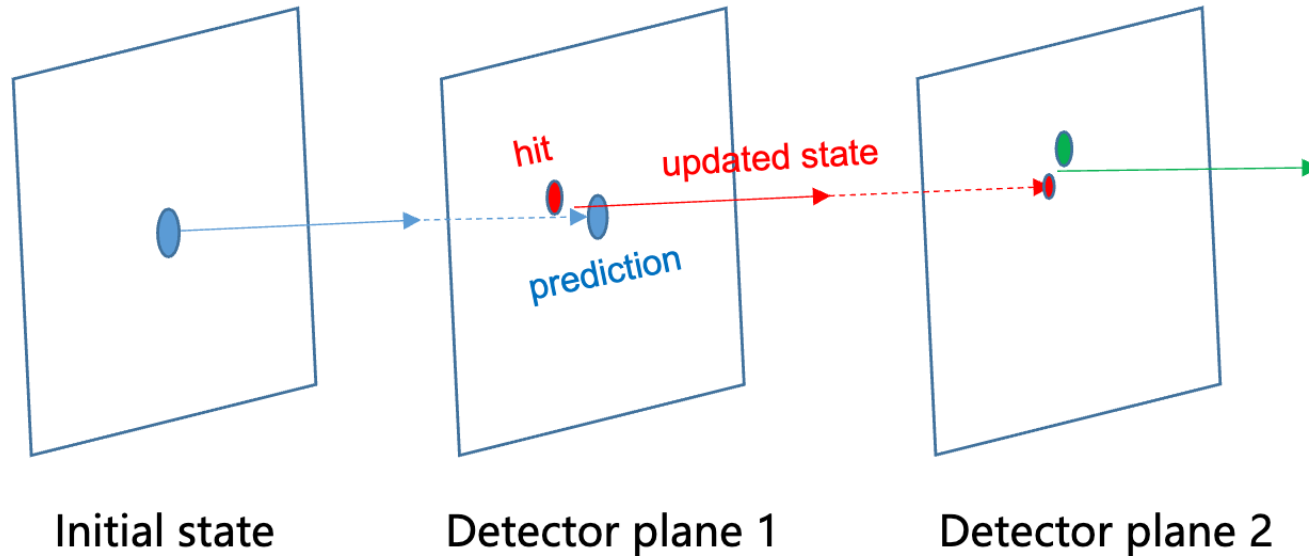
Ion(e)-going direction tracker



Performance study – track finding/fitting

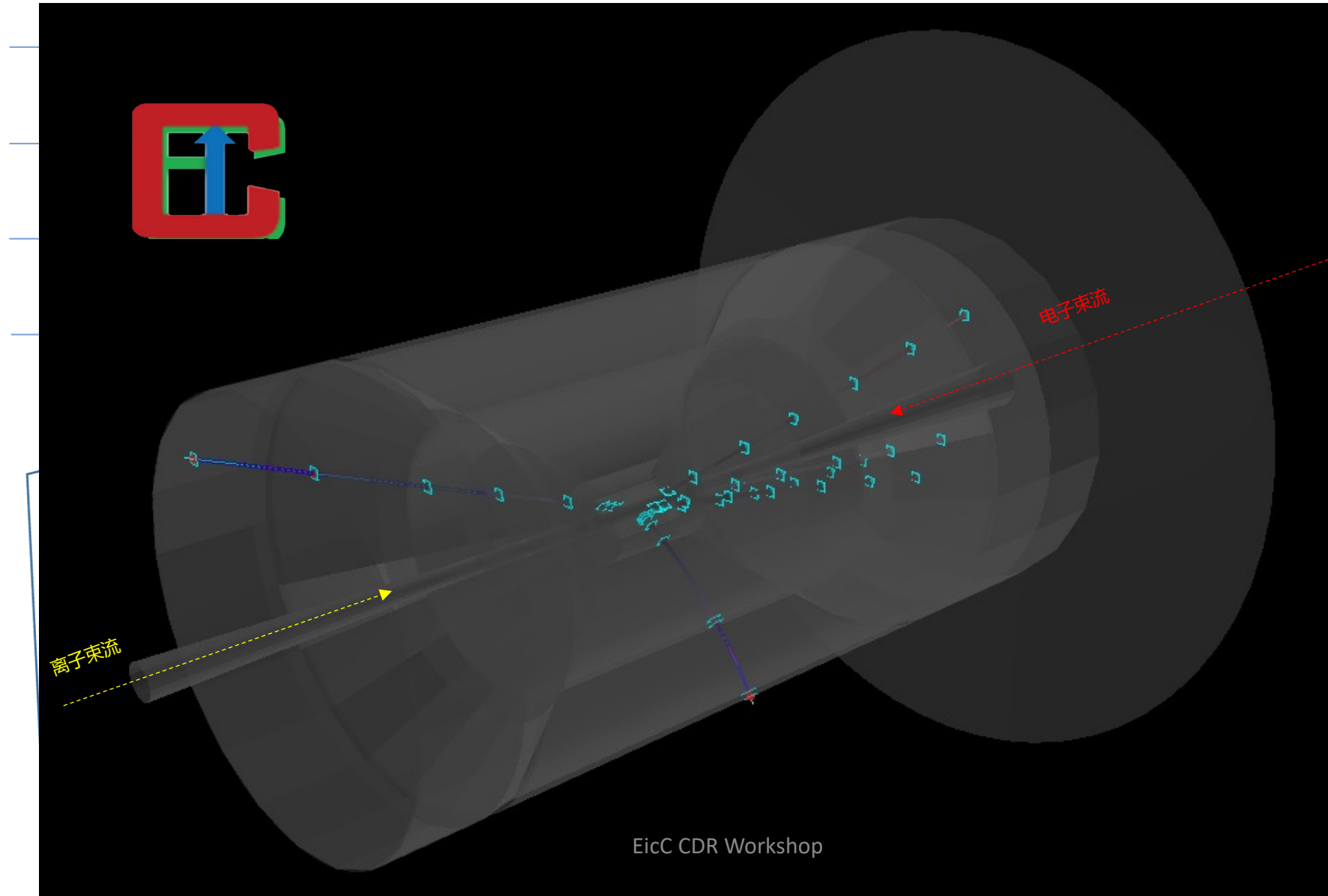


Track finding algorithm is based on Cellular Automaton (On going)

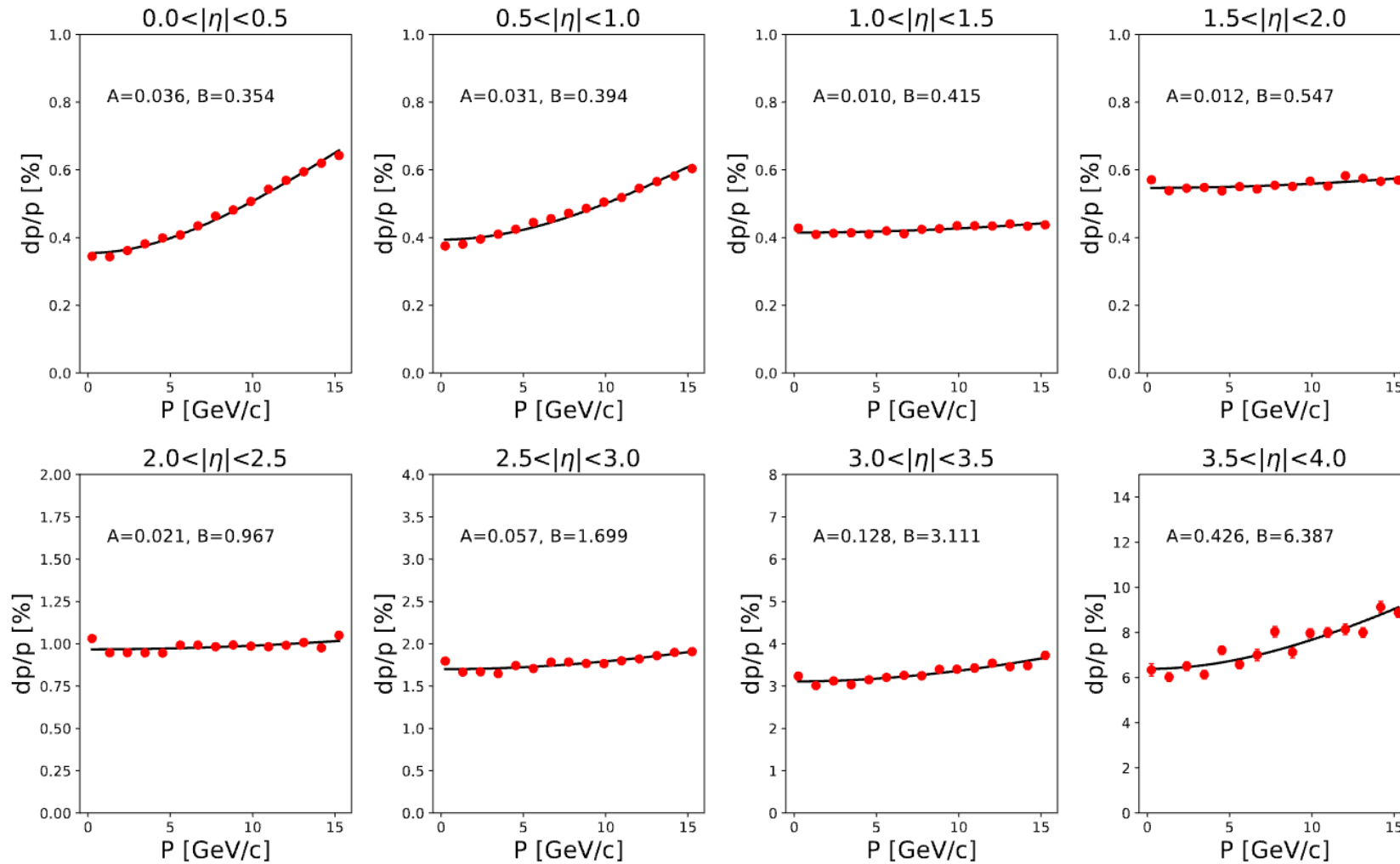


Track fitting algorithm is based on Kalman Filter (Finished)

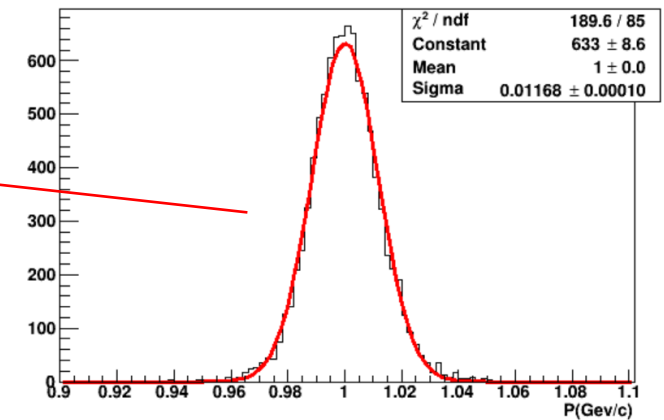
Performance study – track finding/fitting



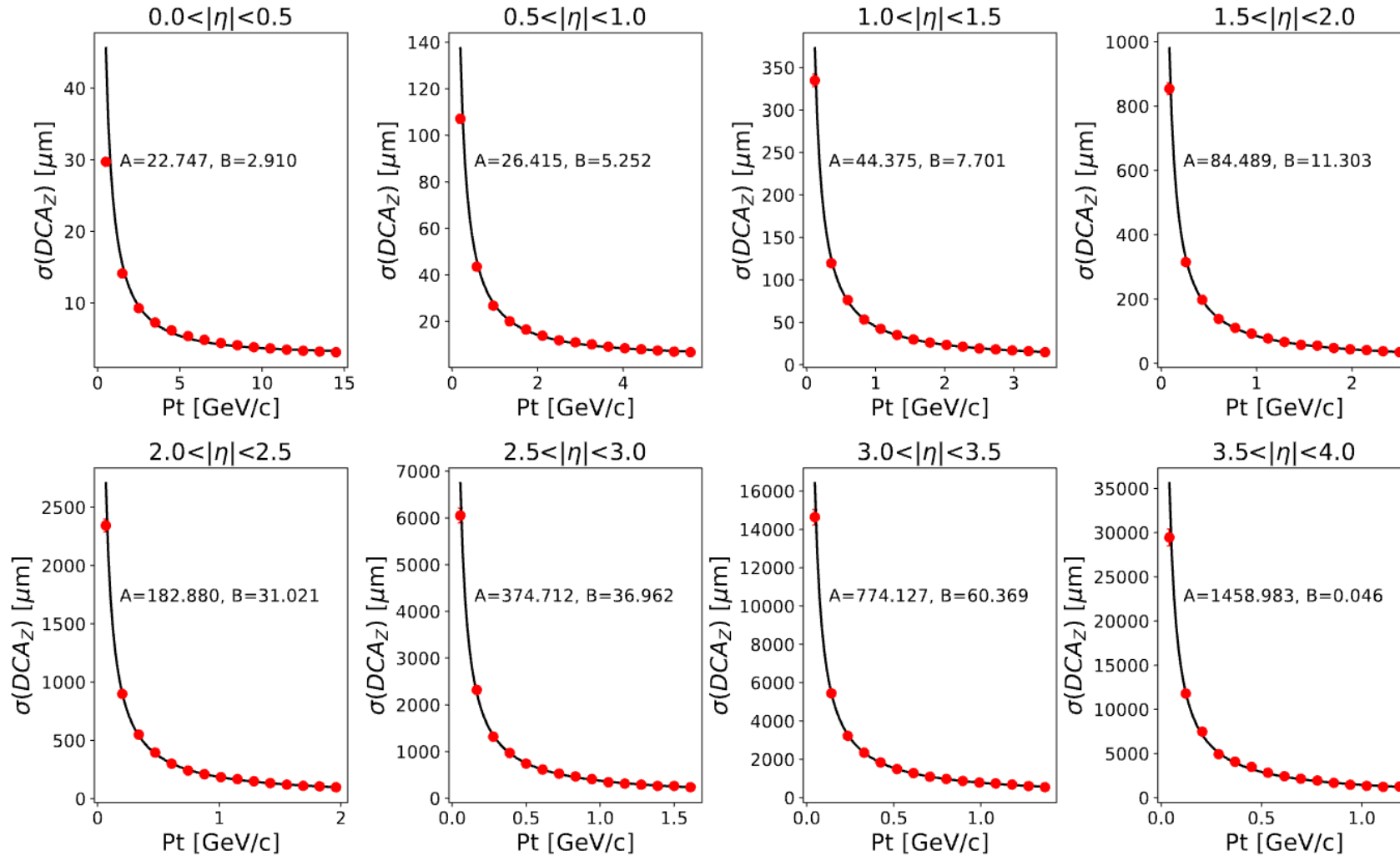
Performance study – momentum resolution



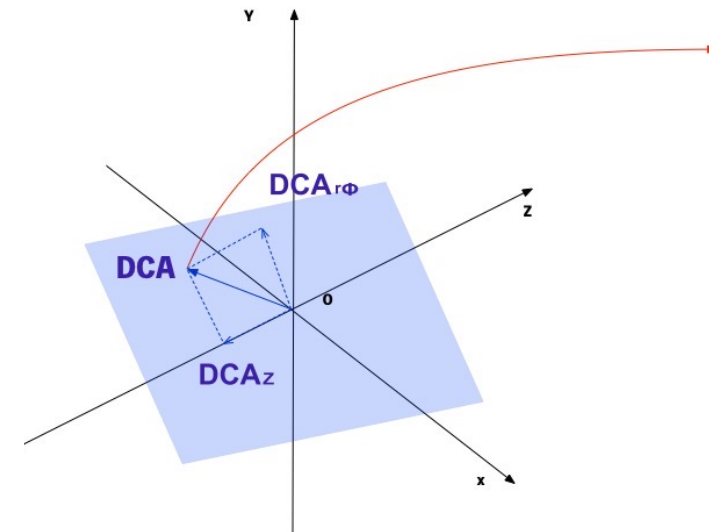
dp/p at different η ,
and parameterized as
 $dp/p = Ap \oplus B$



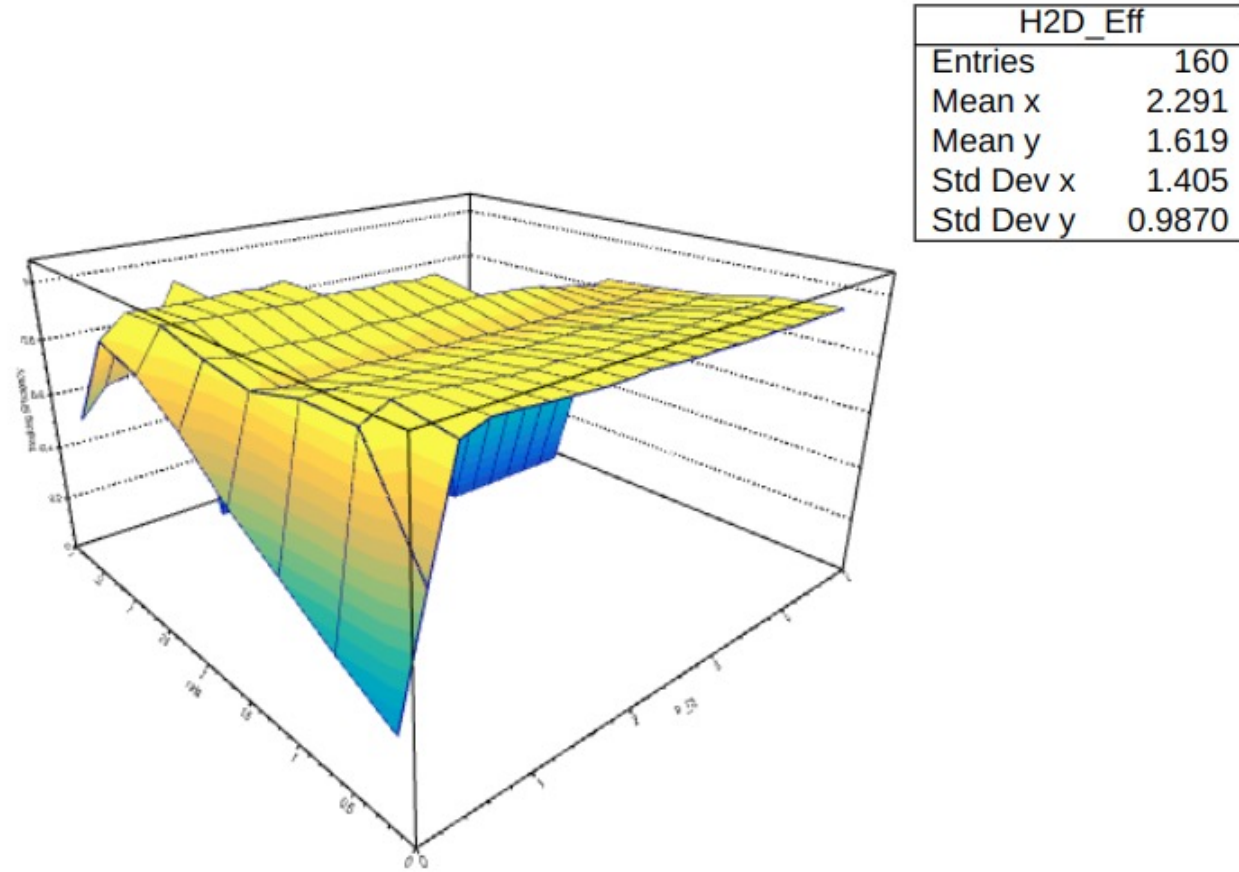
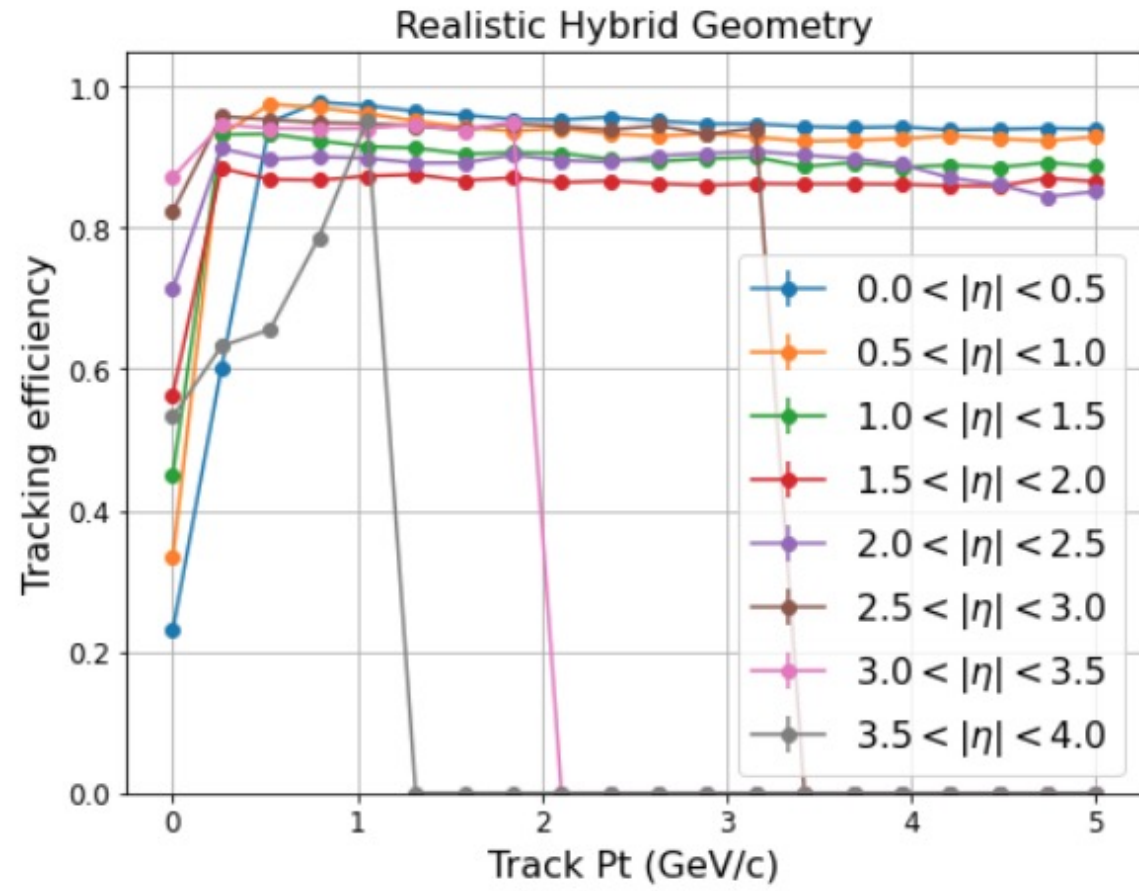
Performance study – DCA resolution



$\sigma(DCA)$ at different η ,
and parameterized as
 $\sigma(DCA) = A/p_t \oplus B$



Tracking efficiency



Performance study – vertex reconstruction

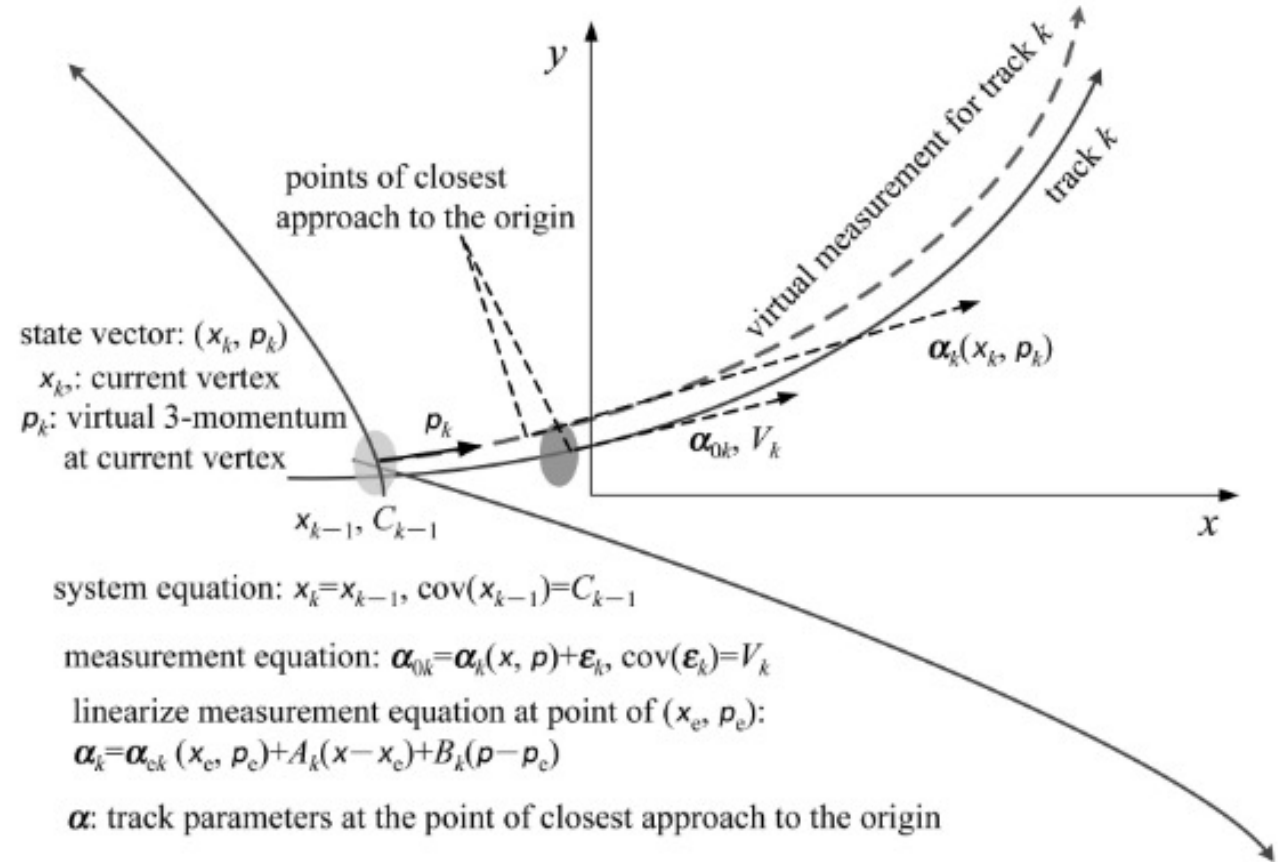
- **Strategy:** updating the vertex position and its covariance matrix step by step through adding a new track k

- For a track,

- State vector (p_k, x_k)
- Measurement equation: $q_k = \tilde{\alpha}(x, p_k) + \varepsilon_k$
- Here, $\tilde{\alpha}(x, p_k) \approx \tilde{\alpha}_e(x_e, p_e) + A(x - x_e) + B(p - p_e)$
- Usually $(x_e, p_e) = (x_{k-1}, p_{0k})$
- Define χ_{KF}^2

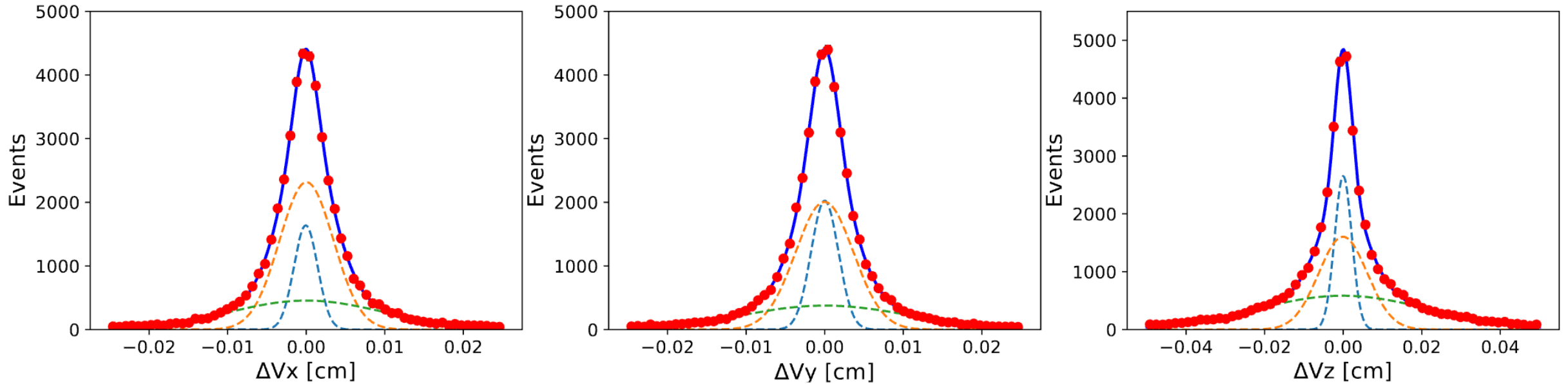
$$\chi_{KF}^2 = (\mathbf{x}_k - \mathbf{x}_{k-1})^T C_{k-1}^{-1} (\mathbf{x}_k - \mathbf{x}_{k-1}) + (\boldsymbol{\alpha}_{0k} - \tilde{\boldsymbol{\alpha}}_k)^T G_k (\boldsymbol{\alpha}_{0k} - \tilde{\boldsymbol{\alpha}}_k),$$

- Minimize χ_{KF}^2 and get solution of x_k and p_k



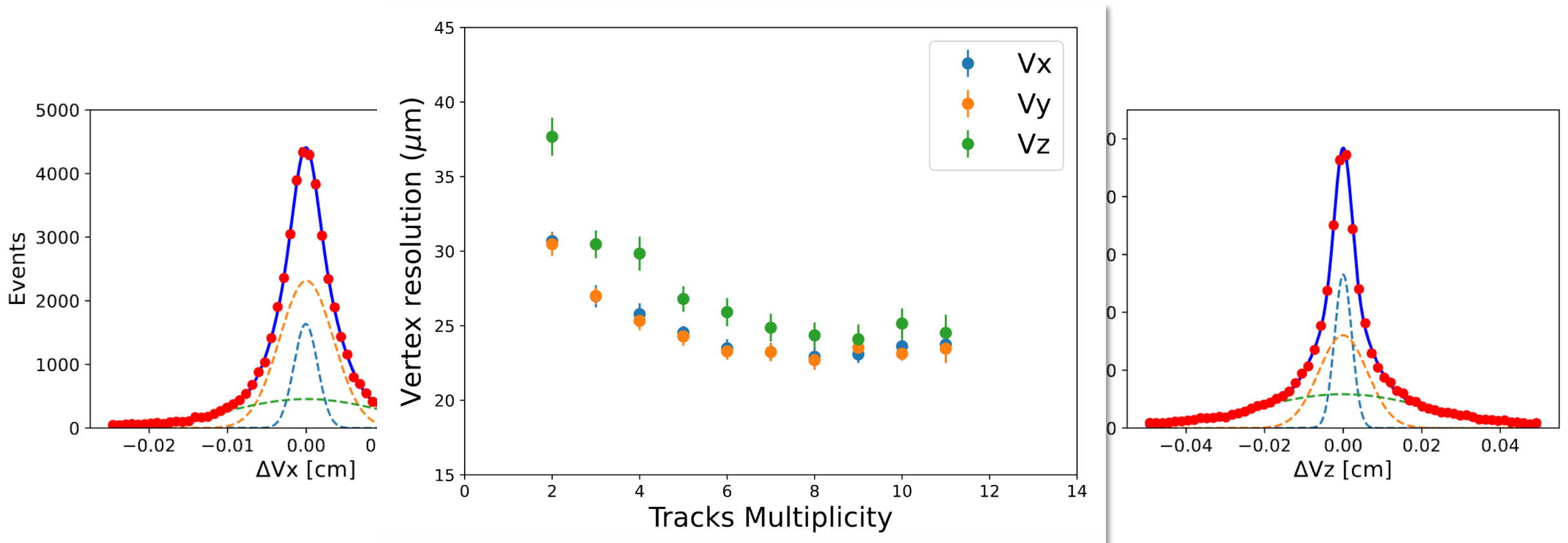
CPC(HEP & NP), 2010, 34(1): 92–98

Performance study – vertex resolution



- The primary vertex is determined through a robust fitting process using the **RAVE** toolkit
- The primary vertex residual distributions contain non-Gaussian tails; Therefore, **three coherent Gaussian functions** are used to parameterize these residual

Performance study – vertex resolution



- The primary vertex is determined through a robust fitting process using the **RAVE** toolkit
- The primary vertex residual distributions contain non-Gaussian tails; Therefore, **three coherent Gaussian functions** are used to parameterize these residual
- The resolution will be improved with respect to track multiplicity

EicC Detector Performance Class

https://gitee.com/aiqiang-guo/EicC_Mvd_DP

AiqiangGuo

代码

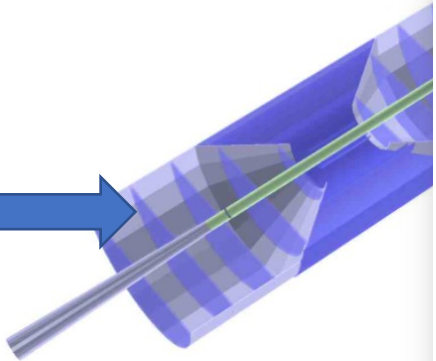
master

AiqiangGuo

- database
- document
- include
- src
- .gitignore
- Eicc_MVD_DP
- LICENSE
- README.md

Det_v0:

Overall description:
All silicon design based on ITS2 technology.
The structure can be found below:

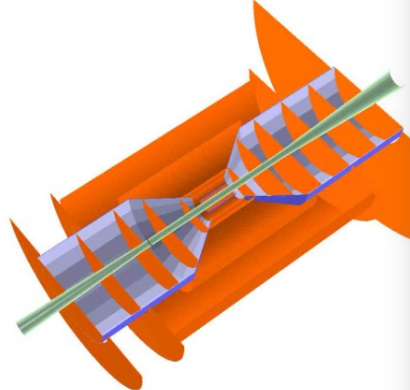


Barrel:

R(cm)	Length(cm)	Pitch Size(μm)	Material Bed
3.30	30	10	0.
5.70	30	10	0.
21.00	54	10	0.
22.68	60	10	0.
39.30	105	10	0.
43.23	114	10	0.

Det_v1:

Overall description:
Silicon+MPGD design. The vertex detector is based on ITS3 technology. Tracking technology.
The structure can be found below:

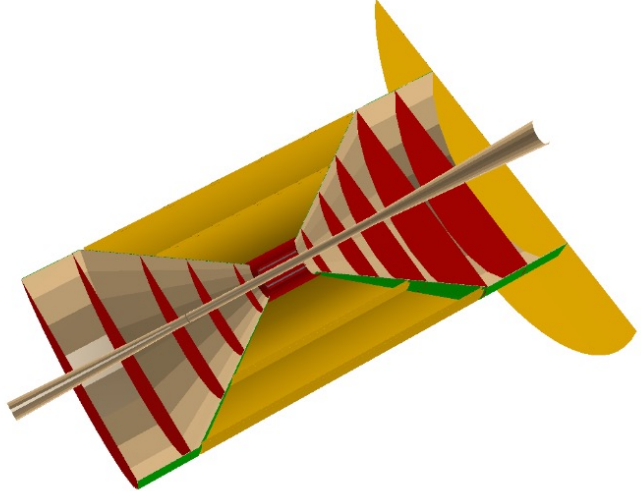


Barrel:

R(cm)	Length(cm)	Pitch Size(μm)	Material Budget (X/X0 %)
3.30	28	10	0.05
4.35	28	10	0.05
5.40	28	10	0.05
13.34	34.34	10	0.55
17.96	46.68	10	0.55
47.72	127.47	150(rp)x150(z)	0.40
49.57	127.47	150(rp)x150(z)	0.40
75.61	201.98	150(rp)x150(z)	0.40
77.46	201.98	150(rp)x150(z)	0.40

Det_v3:

Overall description:
The optimized version of Hybrid design, all the silicon part is based on ITS3 technology with pixel size of 10 μm .
The structure can be found below:



Barrel:

R(cm)	Length(cm)	Pitch Size(μm)	Material Budget (X/X0 %)	Tech
3.30	28	10	0.08	ITS3
4.35	28	10	0.08	ITS3
5.40	28	10	0.08	ITS3
8.00	28	10	0.08	ITS3
15.00	38.70	10	0.08	ITS3
47.72	127.47	150(rp)x150(z)	0.40	MPGD
49.57	127.47	150(rp)x150(z)	0.40	MPGD
75.61	201.98	150(rp)x150(z)	0.40	MPGD
77.46	201.98	150(rp)x150(z)	0.40	MPGD

Parameterization of the performance

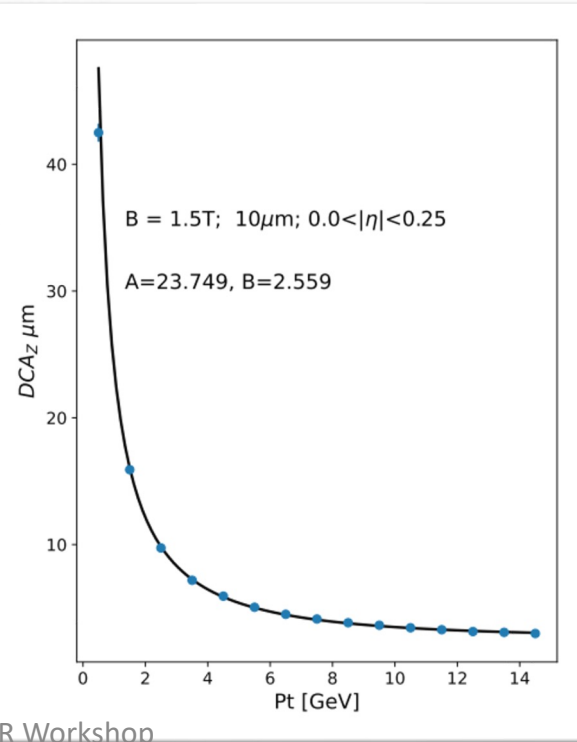
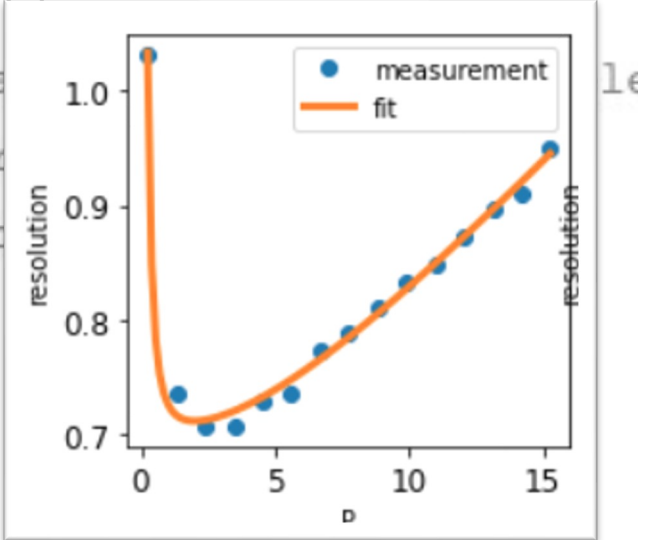
```
//Get the detector resolutions
```

[0,1,2,3,4]=>[e, μ, π, K, p]

```
double GetResP(double p, double eta, int par); // Unit: 1; pa
double GetResDCAz(double pt, double eta, int par); // Unit: micr
double GetResDCArp(double pt, double eta, int par); // Unit:: mic
double GetEff(double pt, double eta, int par); // Unit: 1
```

Performance of track from IP

```
double GetRandomVx(int nTrk); // Unit: mi
double GetRandomVz(int nTrk); // Unit: mi
double GetLambdaRandomVx(double eta); //
double GetLambdaRandomVy(double eta); //
double GetLambdaRandomVz(double eta); //
double GetLambdaResP(double vx, double vy,
double GetLambdaEff(double vx, double vy,
```



```
, double eta, int par);
double eta, int par);
```

Publications

Published in NST

Lambda polarization at Electron-ion collider in China

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Lambda polarization can be measured through its self-analyzing weak decay, making it an ideal candidate for studying spin effects in high energy scatterings. In lepton-nucleon deeply inelastic scatterings (DIS), Lambda polarization measurements can probe the polarized parton distribution functions (PDFs) and the polarized fragmentation functions (FFs). One of the most promising facilities for high-energy nuclear physics research is the proposed Electron-ion collider in China (EicC). As a next-generation facility, EicC is set to propel our understandings of nuclear physics to new heights. In this article, we study the Lambda production in electron-proton collision at EicC energy, in particular Lambda's reconstruction based on the performance of the designed EicC detector. In addition, taking spontaneous transverse polarization as an example, we provide a theoretical prediction with statistical projection based on one month of EicC data taking, offering valuable insights into future research prospects.

Keywords: Electron-ion collider at China; Lambda polarization; polarizing fragmentation functions

Submitted to PRD
production at the EicC

Probing gluon distributions with D^0

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¹⁰*Key Laboratory of Quark and Lepton Physics (MOE) and Institute of Particle Physics,
Central China Normal University, Wuhan 430079, China*

(Dated: August 9, 2023)

Submitted to PRD

Studying charm in-medium modification and hadronization at the Electron-ion Collider in China*

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Submitted to PRD

Exclusive Heavy Quarkonium Production at the Electron-ion collider in China

Xue Wang,^{1,2,*} Xu Cao,^{2,3,†} Aiqiang Guo,^{2,3,‡} Feng-Kun Guo,^{4,5,6,§} Xiao-Shen Kang,^{1,¶} Yu-Tie Liang,^{2,3,**} Peng Sun,^{2,3,††} Jia-Jun Wu,^{5,‡‡} and Ya-Ping Xie^{2,3}

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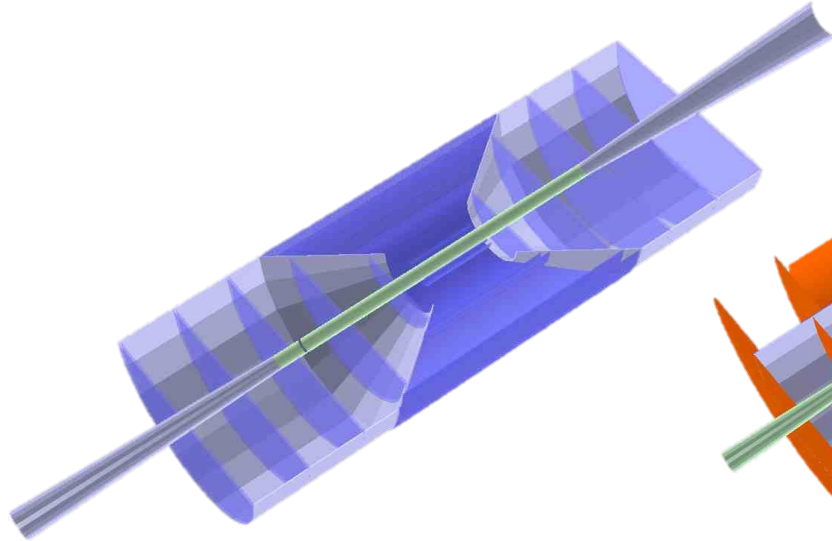
⁶*Peng Huanwu Collaborative Center for Research and Education, Beihang University, Beijing 100191, China*

(Dated: September 15, 2023)

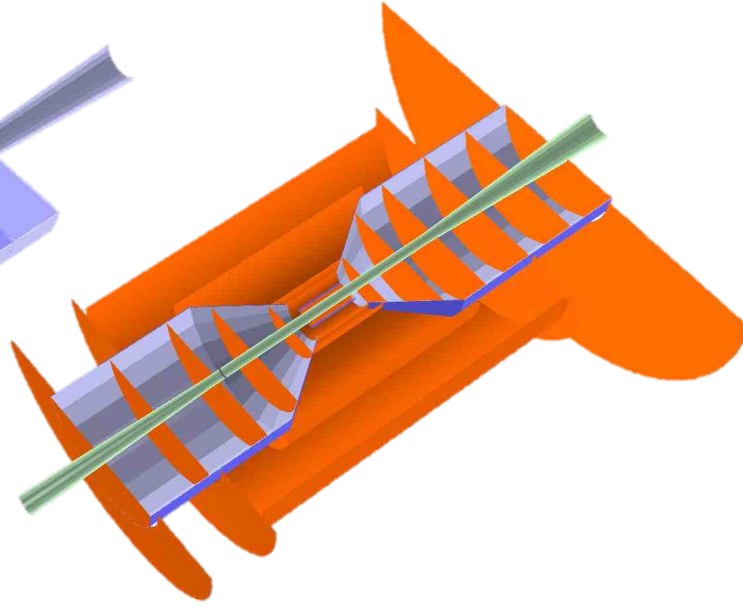
We investigate the exclusive production of heavy quarkonium and exotic states at the future Electron-ion collider in China by utilizing the eSTARlight event generator. We model the cross-section and kinematics by fitting to the world data of J/ψ photoproduction. Statistical uncertainties on J/ψ production are projected under the design of a central detector composed of a tracker and vertex subsystem. The precision of the pseudo-data allows us to probe the gravitational form factor, pentaquark states, rescattering effect and other selected physical quantities. The detector design and optimization enable the prospects for approaching near-threshold region and the domain of large four-momentum transfer squared.

The evolution of the EicC tracker design

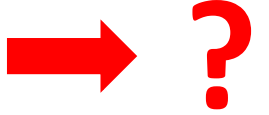
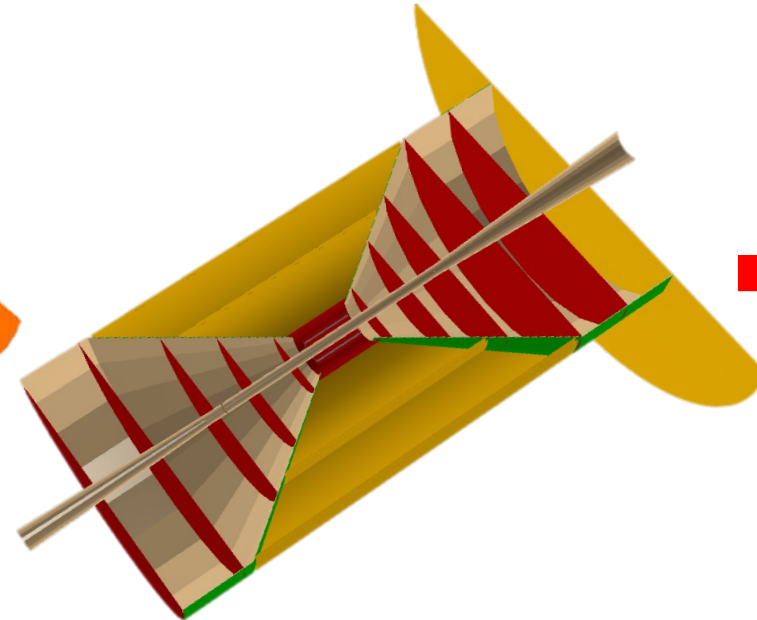
Det_v0



Det_v1/2



Det_v3



- All-silicon based on ITS2

- Silicon+MPGD Hybrid design
- Silicon: vertex ITS3 + tracker ITS2
- Only the pixel size is different for v1/v2

- Silicon+MPGD Hybrid design
- Silicon: ITS3
- Geometry is Optimized

The tools we have

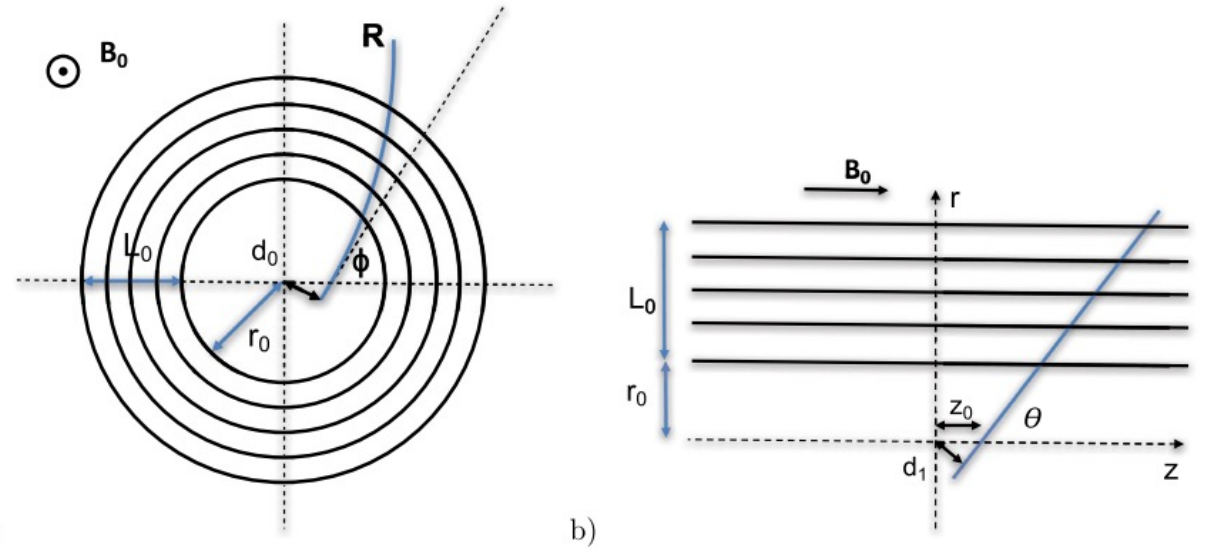
- By simulation
 - Very time consuming
- By analytic expressions
 - We need to know all the factors that affect the resolution
- Track model: $f(x) = \sum_i a_i g_i(x)$ with M unknown parameters
- N measurement y_n ,
- The parameters a_i are estimated by minimize

$$\chi^2 = \sum_{m=0}^N \sum_{n=0}^N \left[y_m - \sum_{i=0}^M a_i g_i(x_m) \right] W_{mn} \left[y_n - \sum_{i=0}^M a_i g_i(x_n) \right]$$

Track parameter

$$\chi^2 = (\mathbf{y} - \mathbf{G}\mathbf{a})^T \mathbf{W}(\mathbf{y} - \mathbf{G}\mathbf{a})$$

measurement



To minimise χ^2 we have to solve $\frac{\partial \chi^2}{\partial a_i} = 0$ which gives

$$\mathbf{a} = (\mathbf{G}^T \mathbf{W} \mathbf{G})^{-1} \mathbf{G}^T \mathbf{W} \mathbf{y} = \mathbf{B} \mathbf{y}$$

The error of \mathbf{a} can be determined by the errors of \mathbf{y}

$$\mathbf{C}_a = (\mathbf{G}^T \mathbf{C}_y^{-1} \mathbf{G})^{-1} \quad \mathbf{C}_y \text{ is the covariance matrix of } \mathbf{y}$$

The tools we have

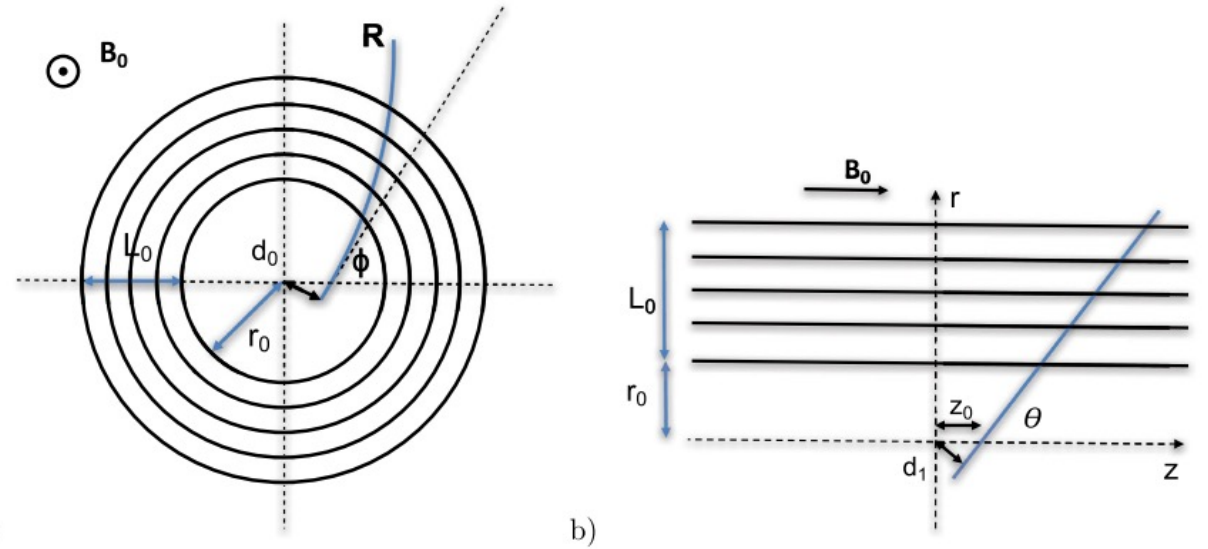
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Track parameter

$$\chi^2 = (\mathbf{y} - \mathbf{G}\mathbf{a})^T \mathbf{W}(\mathbf{y} - \mathbf{G}\mathbf{a})$$

measurement



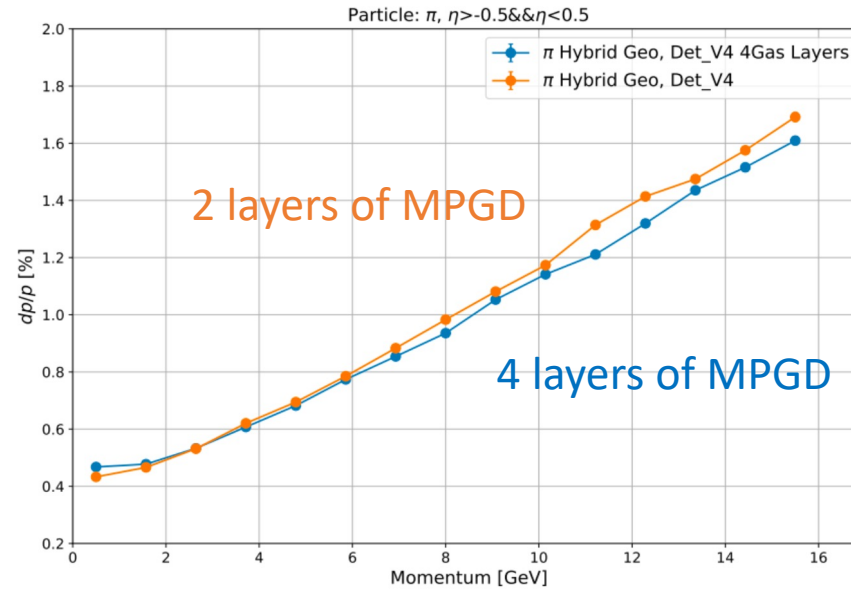
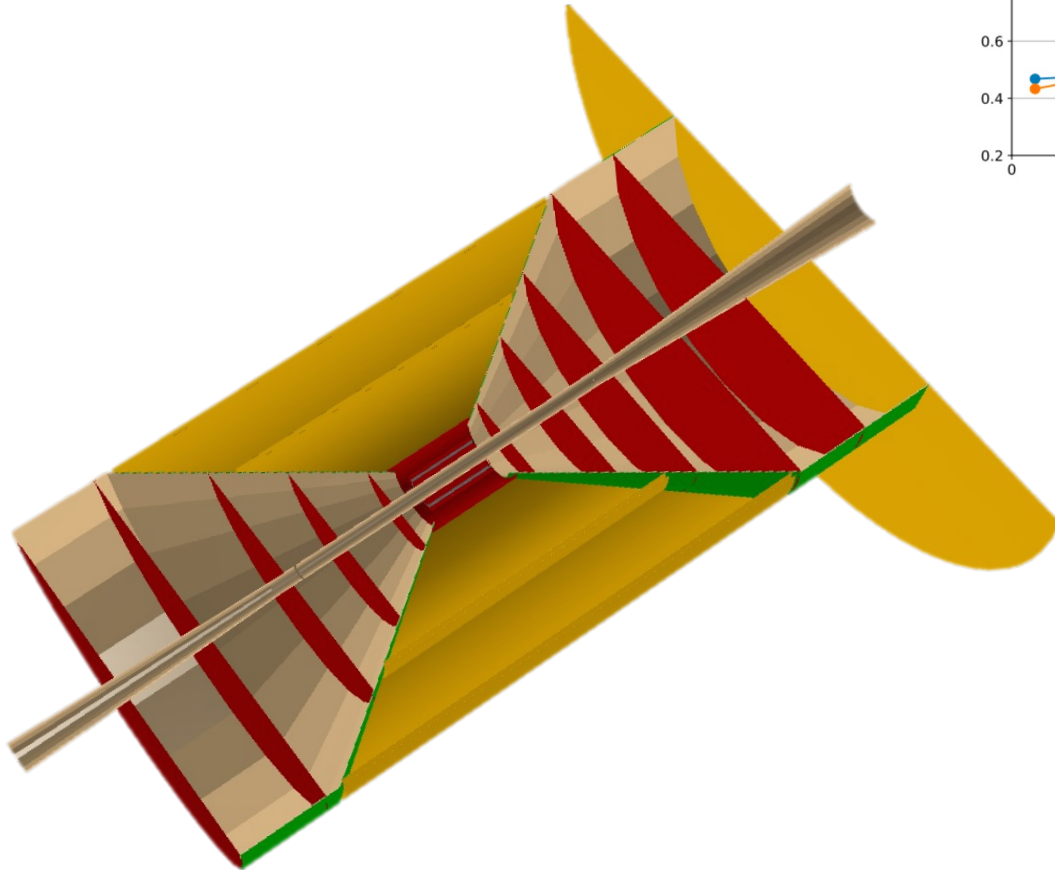
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$$\mathbf{a} = (\mathbf{G}^T \mathbf{W} \mathbf{G})^{-1} \mathbf{G}^T \mathbf{W} \mathbf{y} = \mathbf{B} \mathbf{y}$$

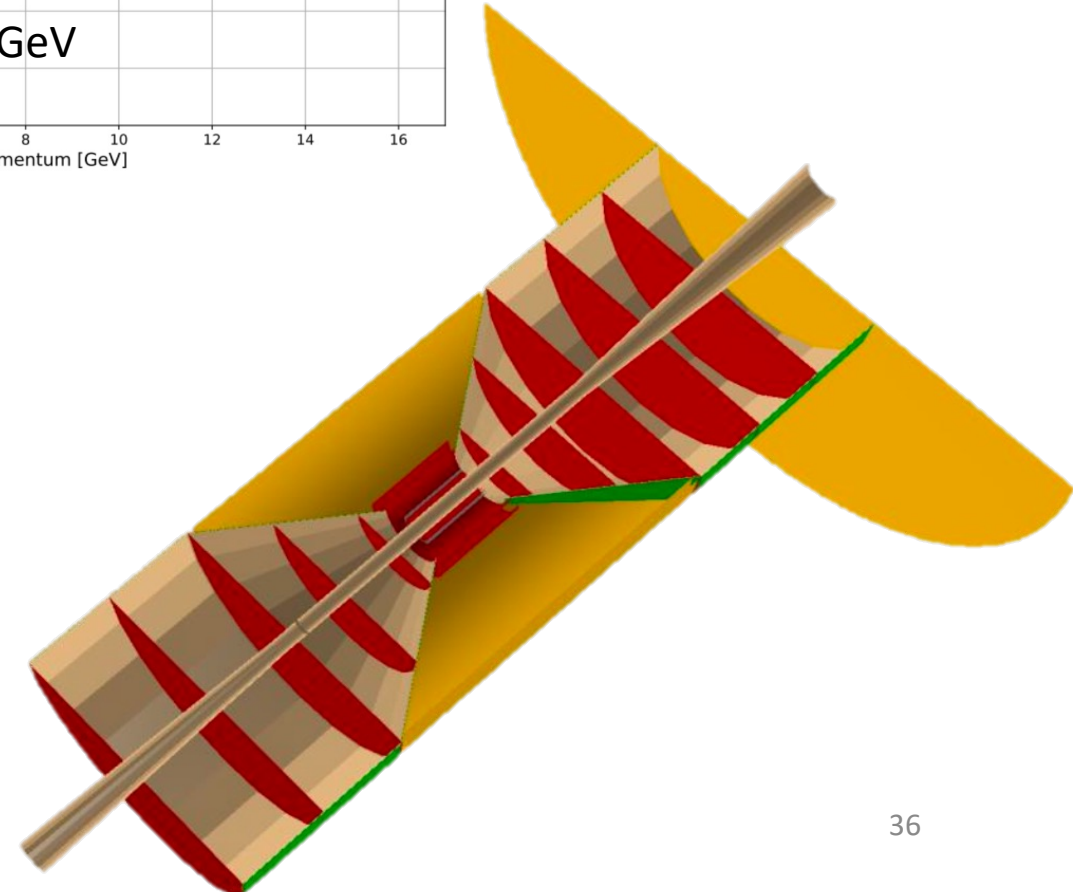
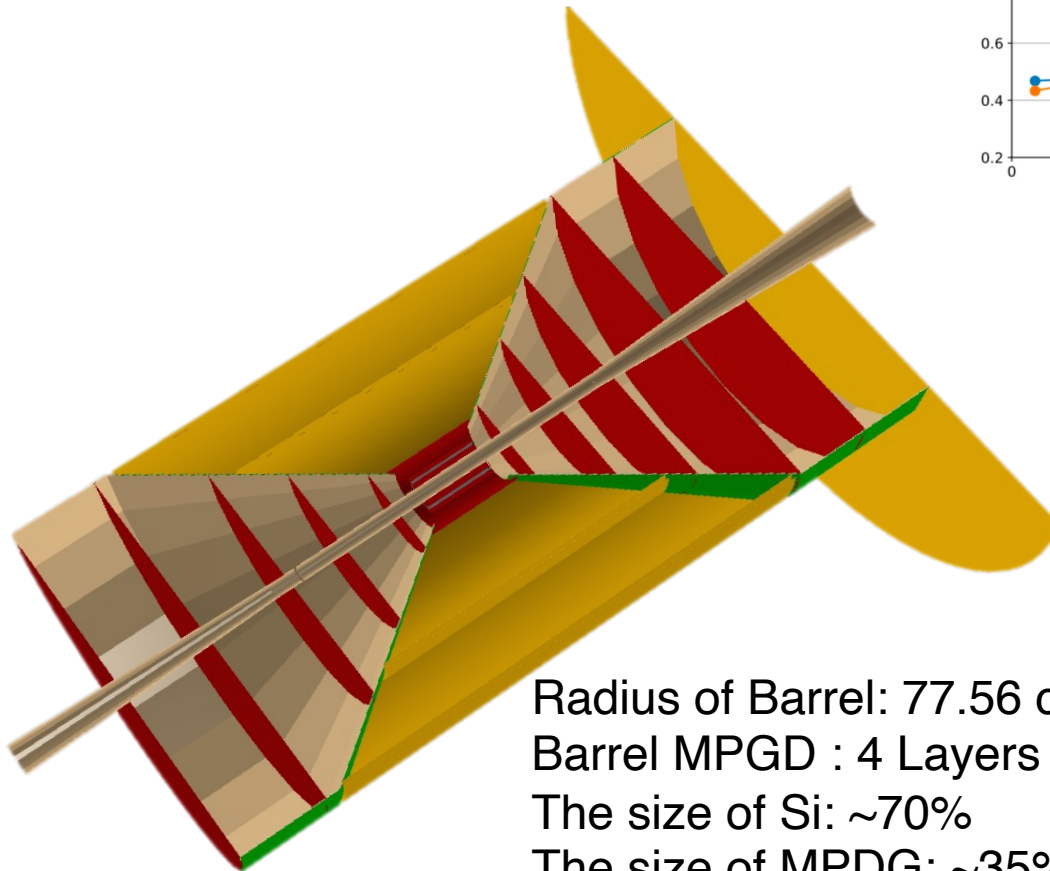
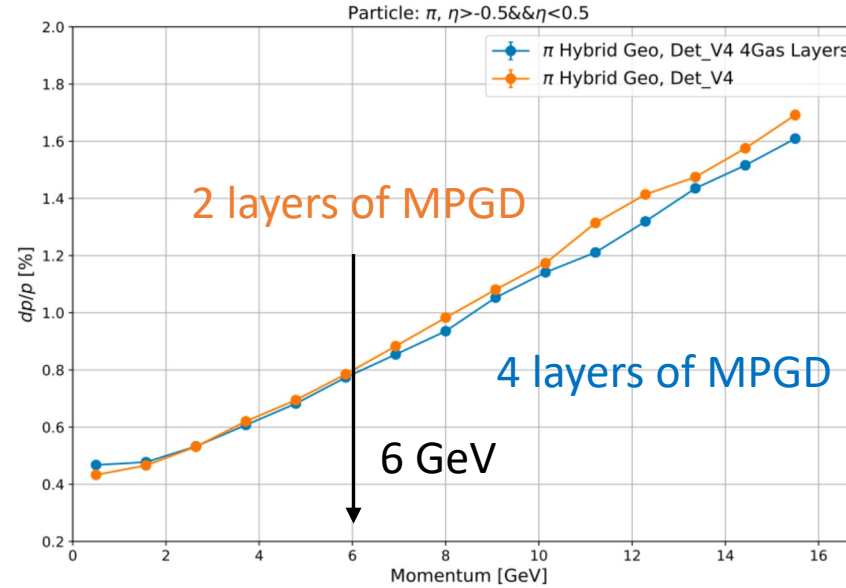
The error of \mathbf{a} can be determined by the errors of \mathbf{y}

$$\mathbf{C}_a = (\mathbf{G}^T \mathbf{C}_y^{-1} \mathbf{G})^{-1} \quad \mathbf{C}_y \text{ is the covariance matrix of } \mathbf{y}$$

Number of layer



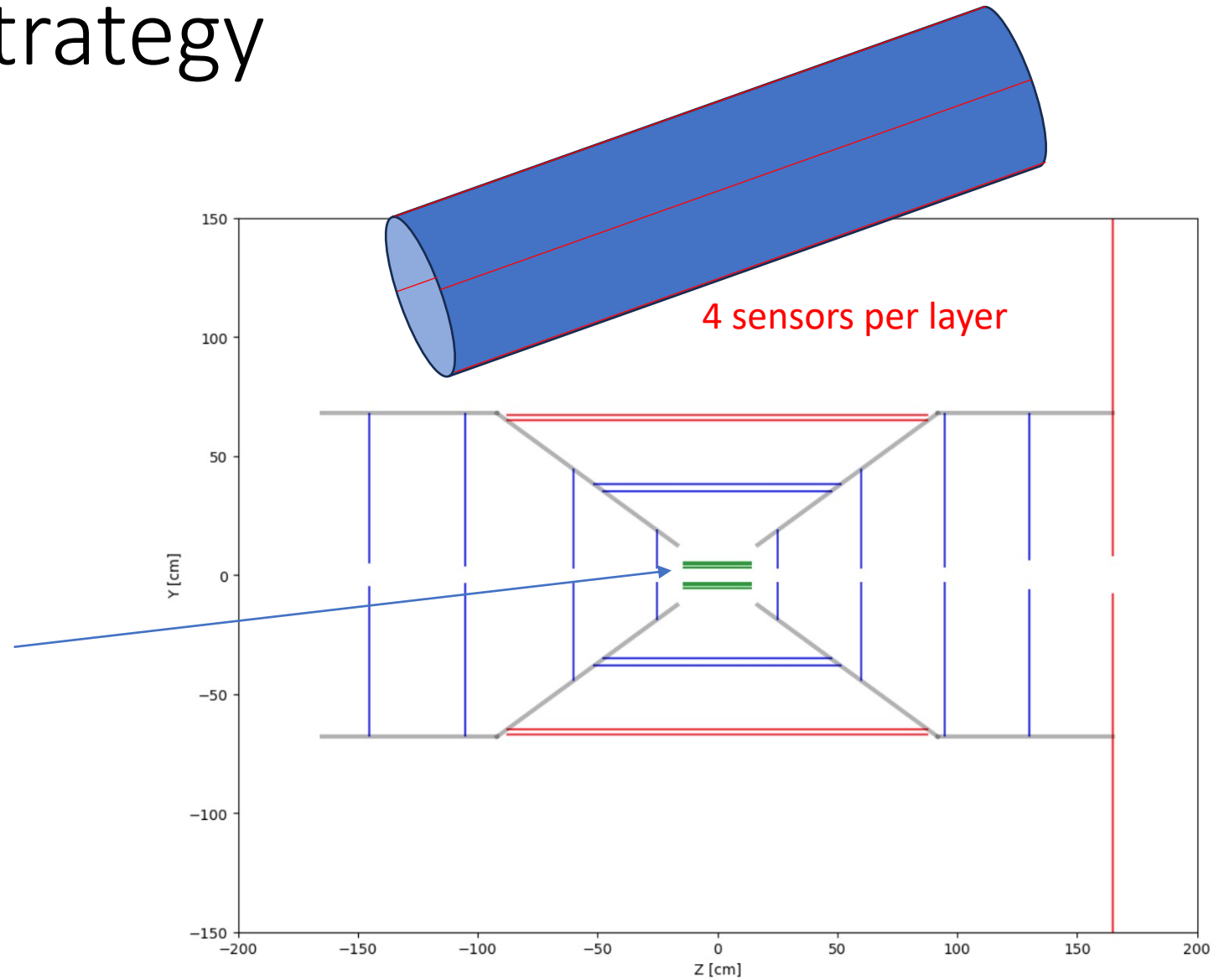
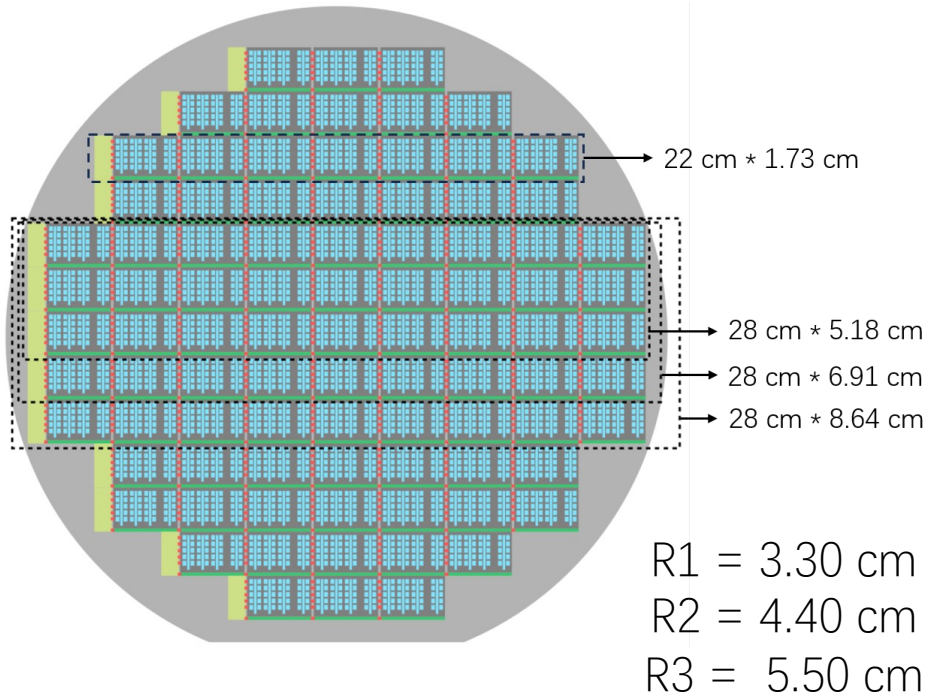
Number of layer



Radius of Barrel: 77.56 cm \rightarrow 55 cm
 Barrel MPGD : 4 Layers \rightarrow 2 Layers
 The size of Si: $\sim 70\%$
 The size of MPDG: $\sim 35\%$

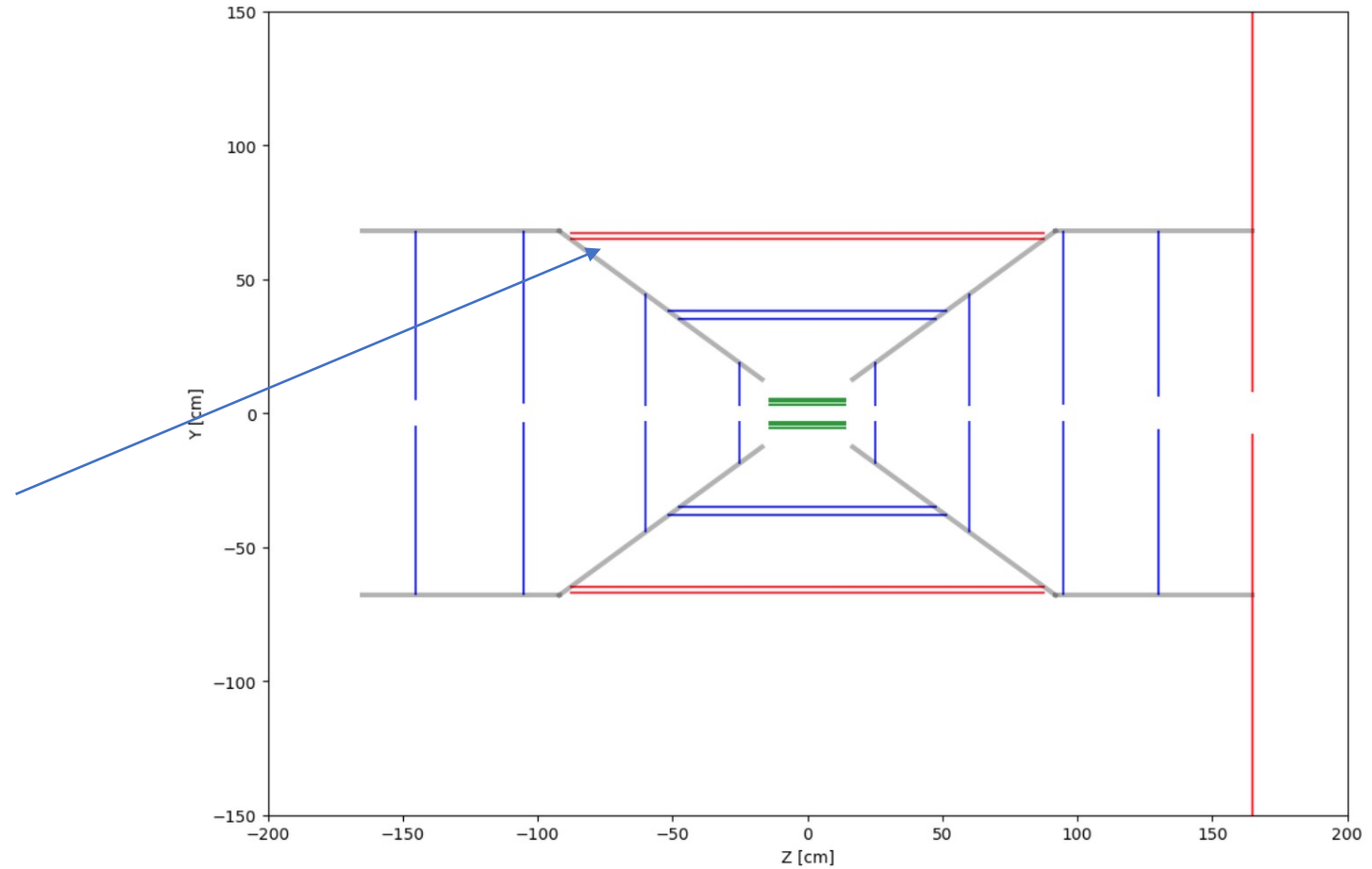
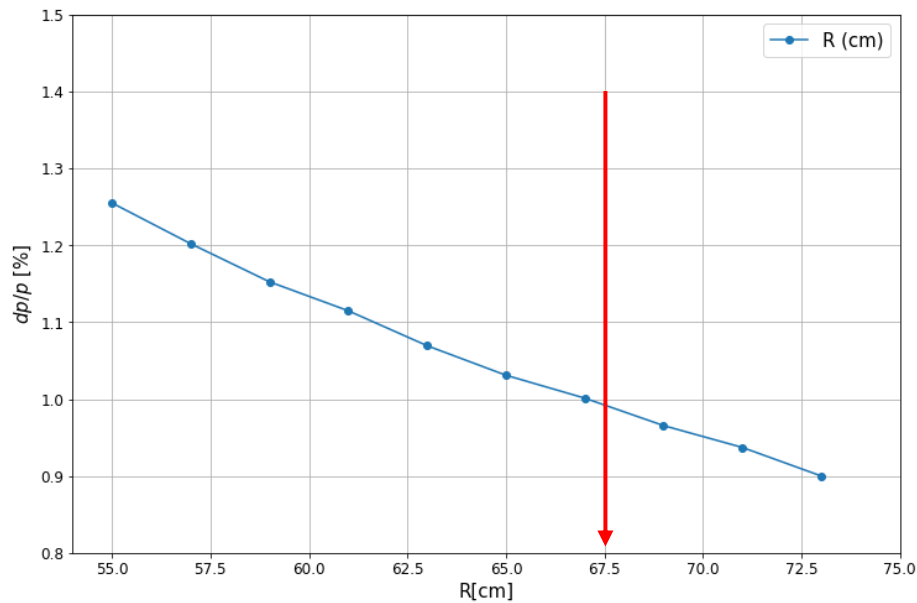
The optimization strategy

The geometry of vertex part is fixed due to the constrain of wafer size



The optimization strategy

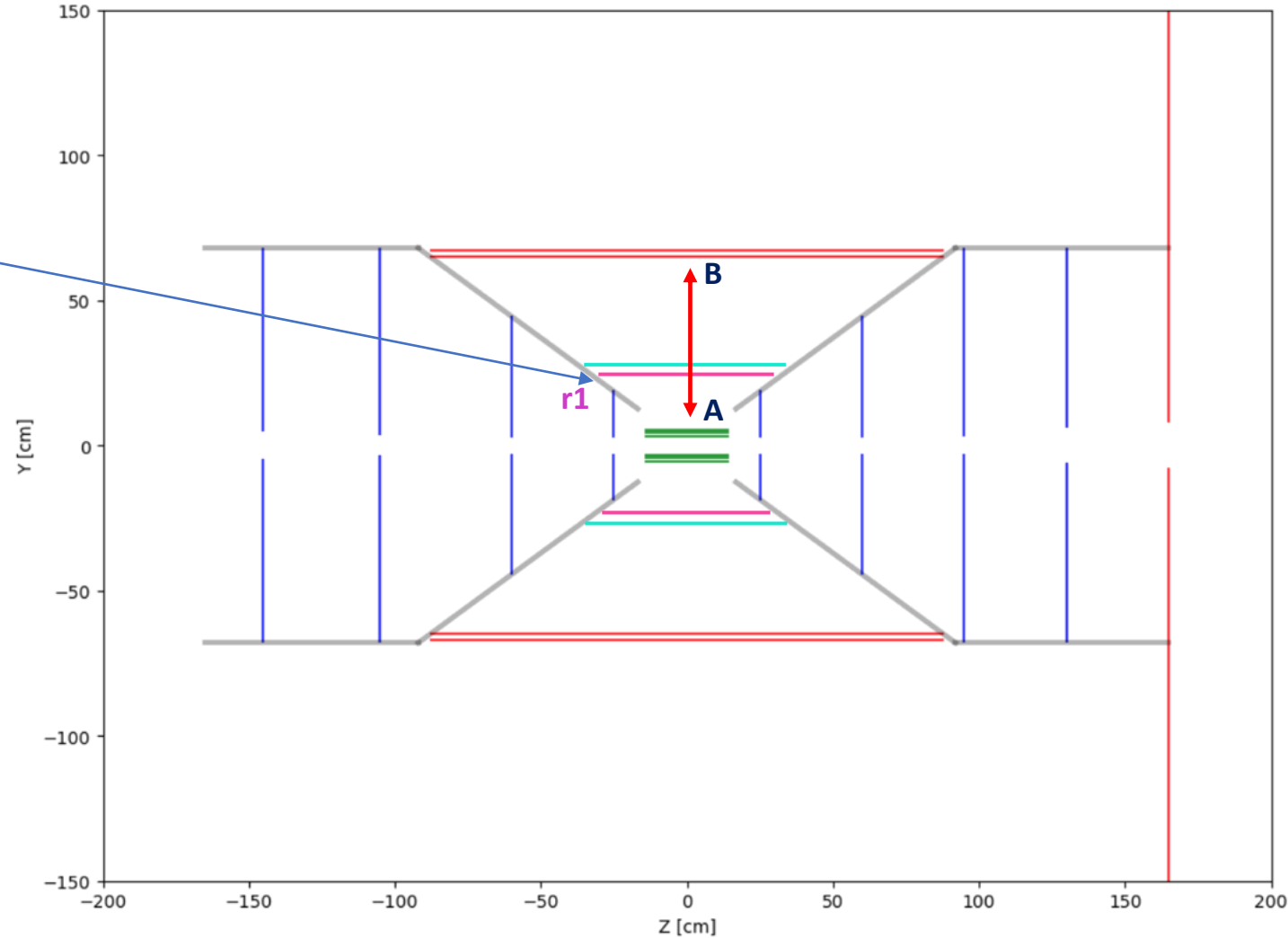
- The radius of the outmost layer is determined by physical requirement:
 $dp/p < 1\%$ @ 4GeV
- **$R = 67.5$ cm**



The optimization strategy

The radius of the middle two layers are optimized by a 2D scanning for $p = 1\text{GeV}$:

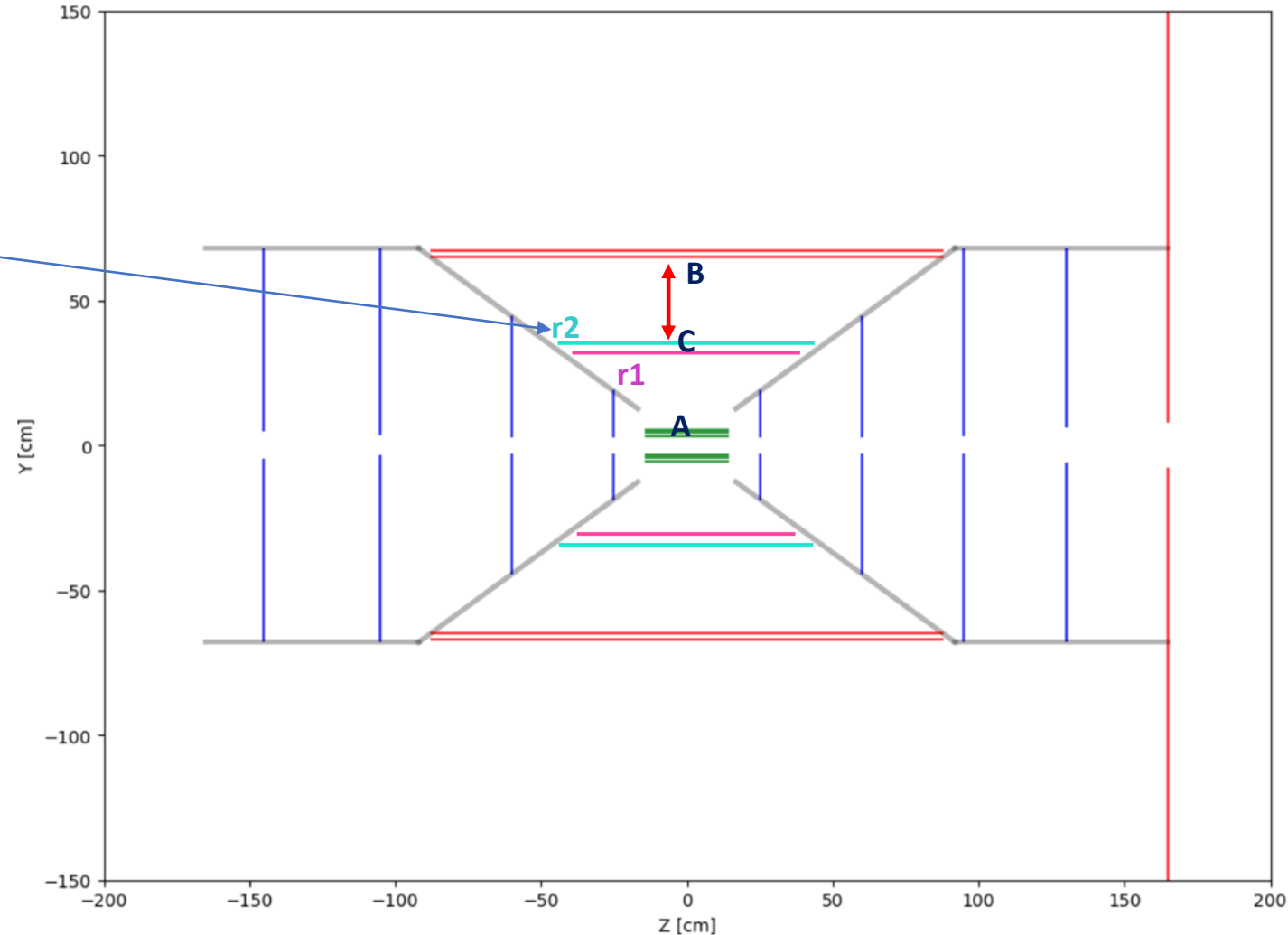
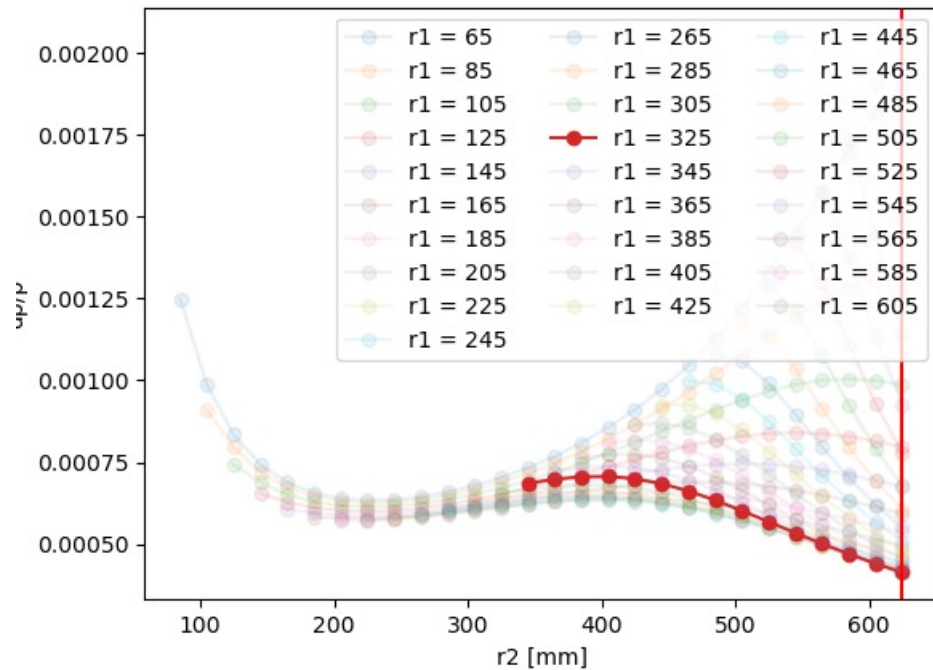
1. Scan r_1 from A \rightarrow B



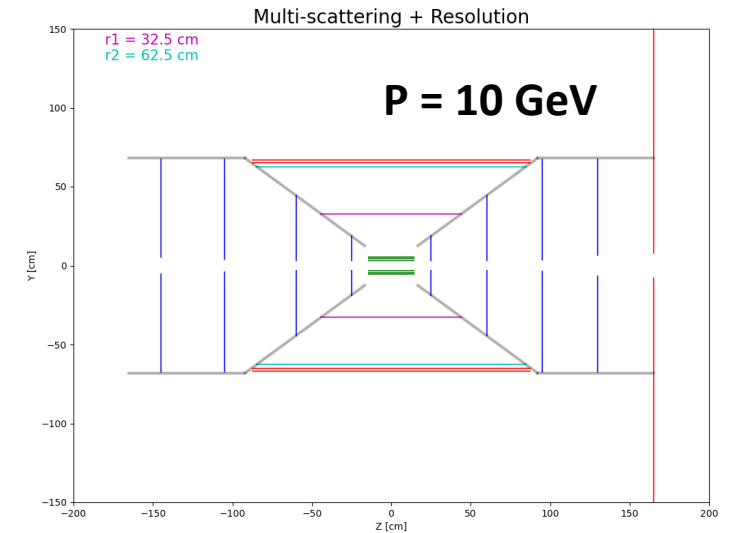
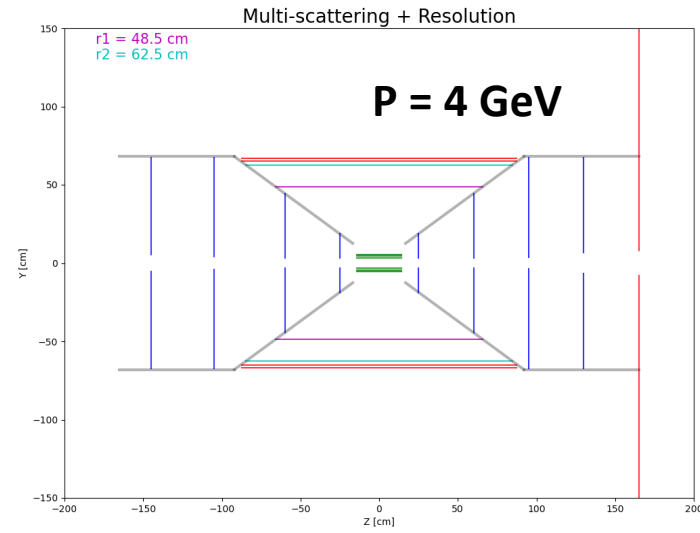
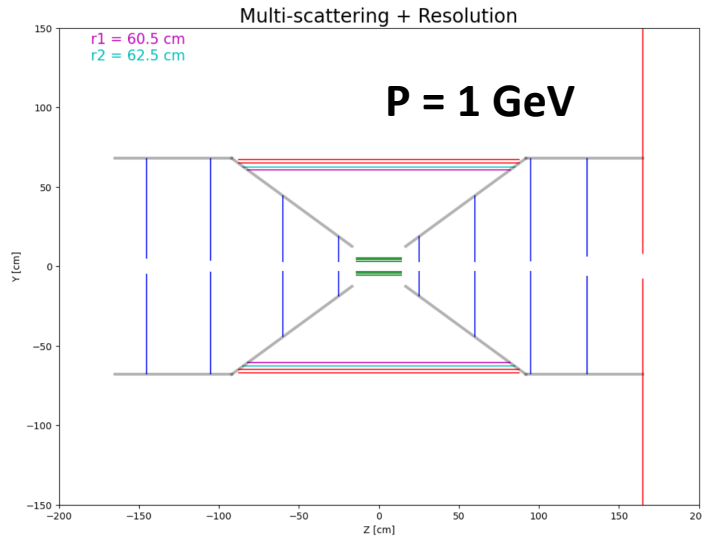
The optimization strategy

The radius of the middle two layers are optimized by a 2D scanning for $p = 1\text{GeV}$:

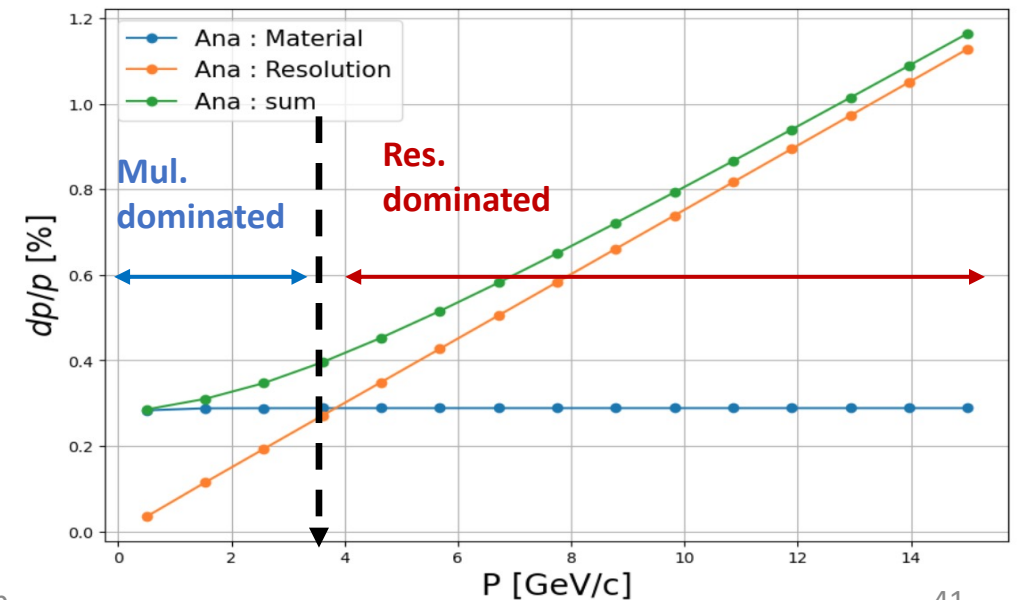
1. Scan $r1$ from A \rightarrow B
2. For each $r1$ position, scan $r2$ from C \rightarrow B



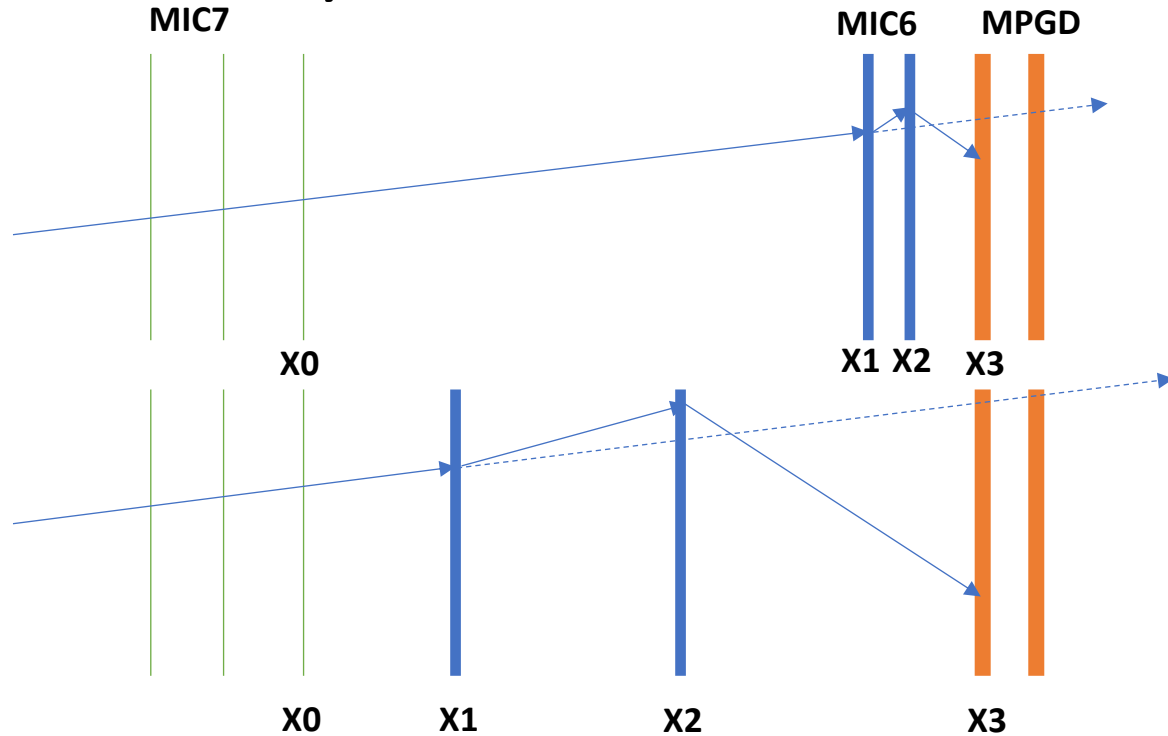
Conclusion



- The multi-scattering effect will push all two tracker layers to the outer-most layer
- The resolution effect will pull the inner tracker towards the middle of detector



But why ?



- The multi-scattering effect will push all two tracker layers to the outer-most layer
- The resolution effect will pull the inner tracker towards the middle of detector

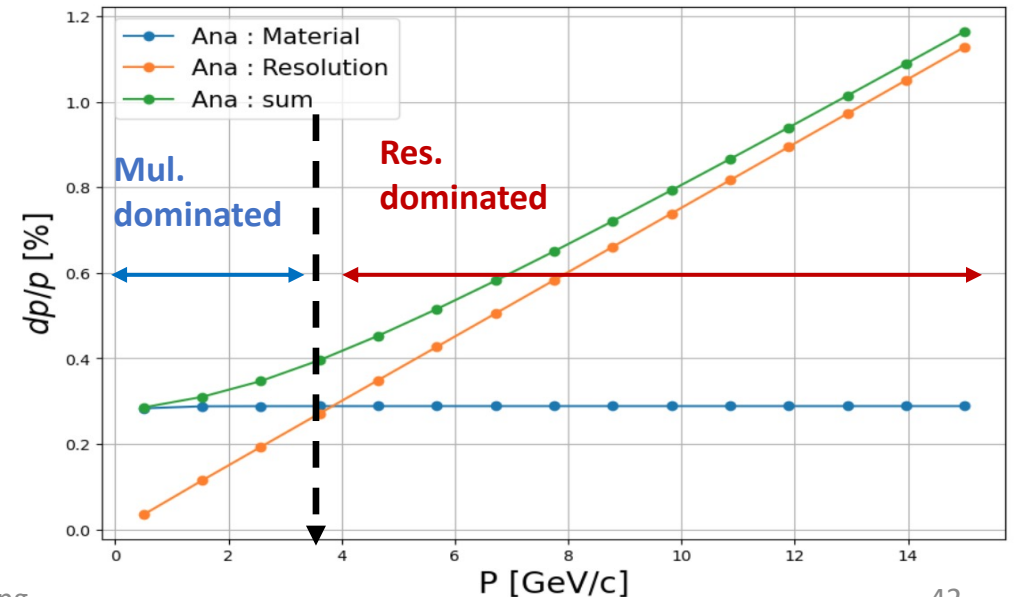
Due to resolution

Determined by material budget

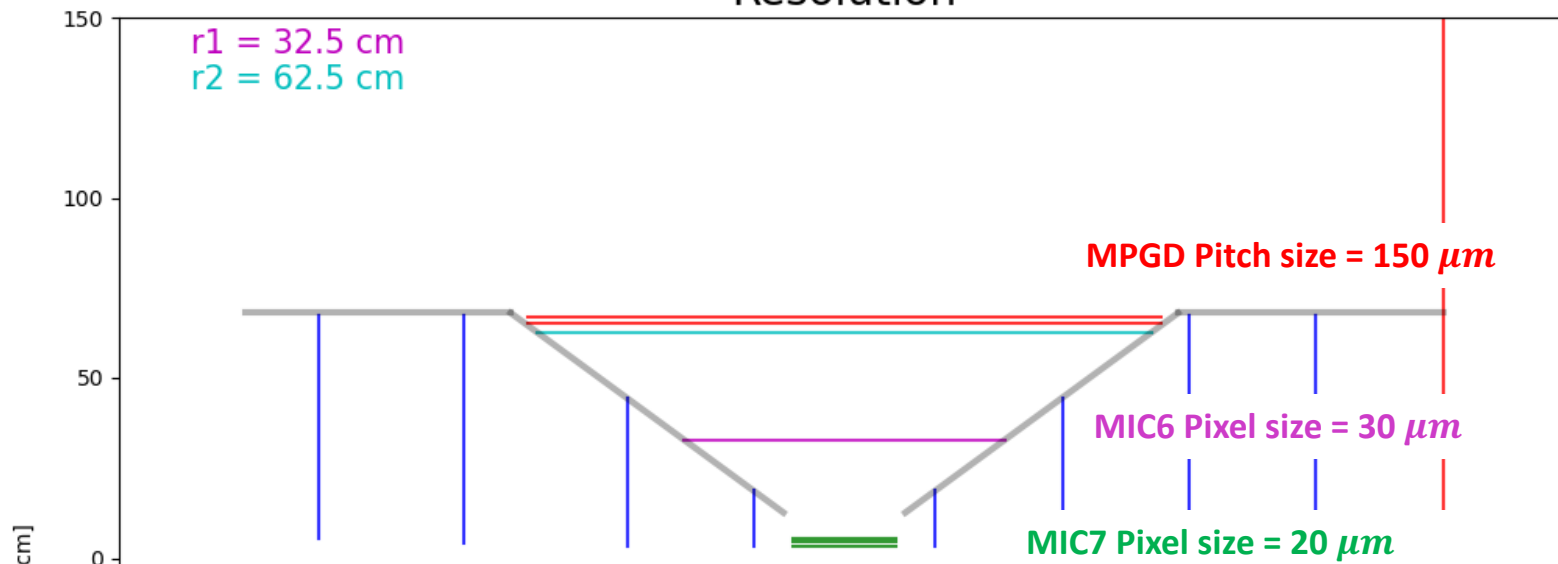
$$\begin{aligned}
 y_0 &= f(x_0) + u_0 \\
 y_1 &= f(x_1) + u_1 + \alpha_0(x_1 - x_0) \\
 y_2 &= f(x_2) + u_2 + \alpha_0(x_2 - x_0) + \alpha_1(x_2 - x_1) \\
 &\vdots \\
 y_n &= f(x_n) + u_n + \sum_{m=0}^{n-1} \alpha_m(x_n - x_m) \quad n = 0, 1, \dots, N
 \end{aligned}$$

The covariance matrix of y_n is therefore

$$(C_y)_{mn} = \sigma_n^2 \delta_{mn} + \sum_{j=0}^{\text{Min}[m,n]-1} \sigma_{\alpha_j}^2 (x_m - x_j)(x_n - x_j)$$

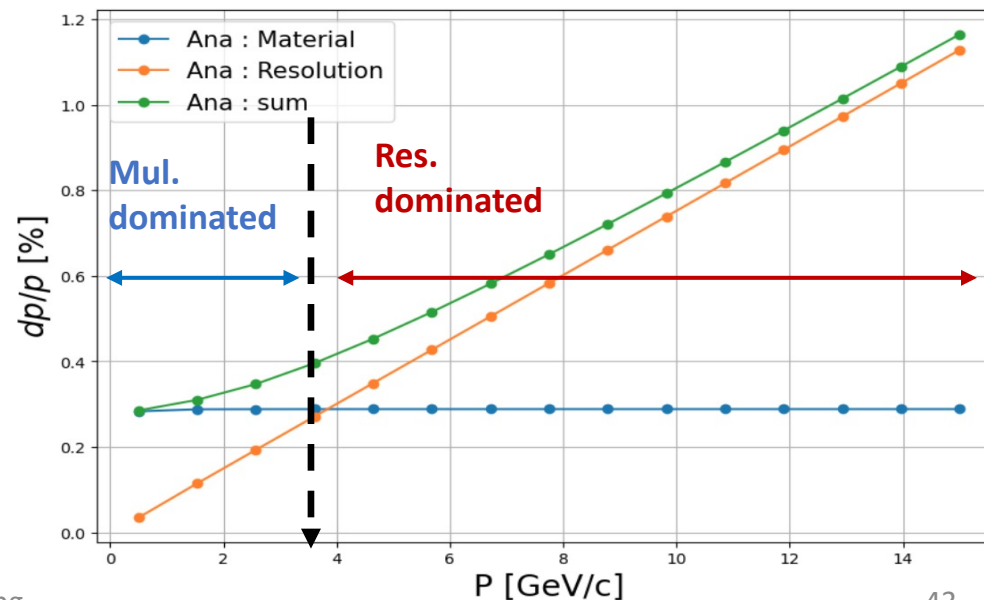


Resolution



The resolution of MPGD is too bad compared to silicon layer !!

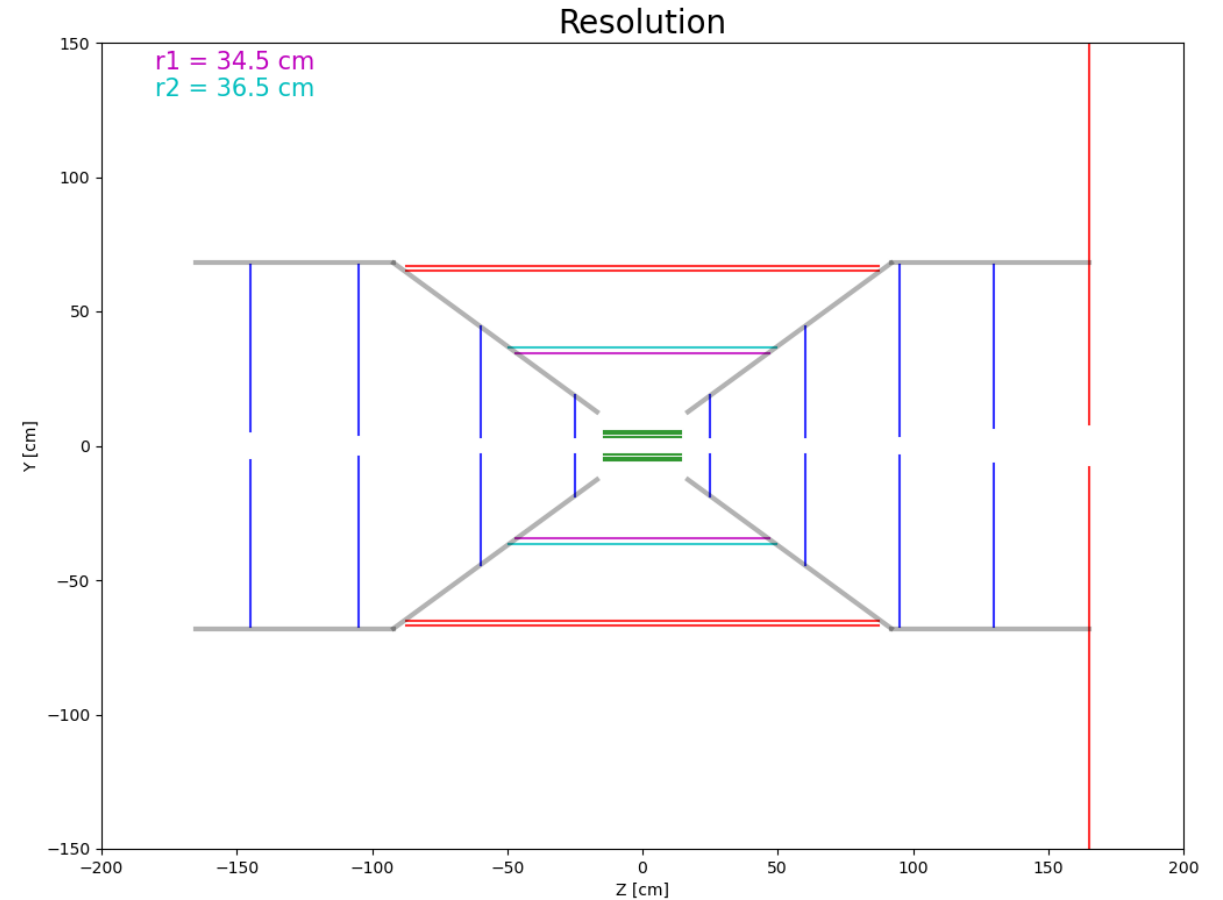
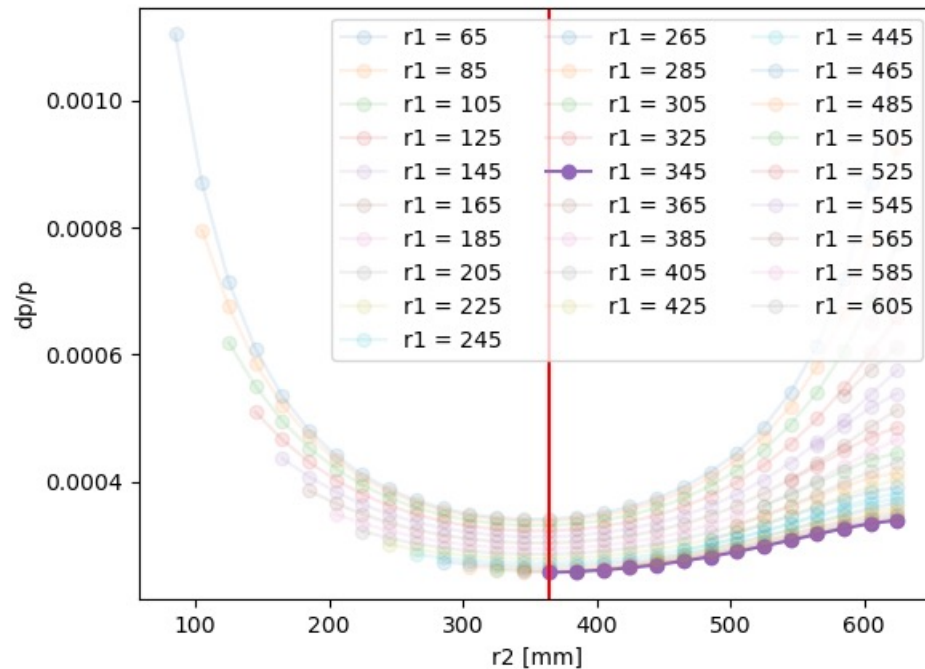
- The multi-scattering effect will push all two tracker layers to the the outer-most layer
- The resolution effect will pull the inner tracker towards the middle of detector



The optimized result with MPGD pitch size = $20\ \mu\text{m}$

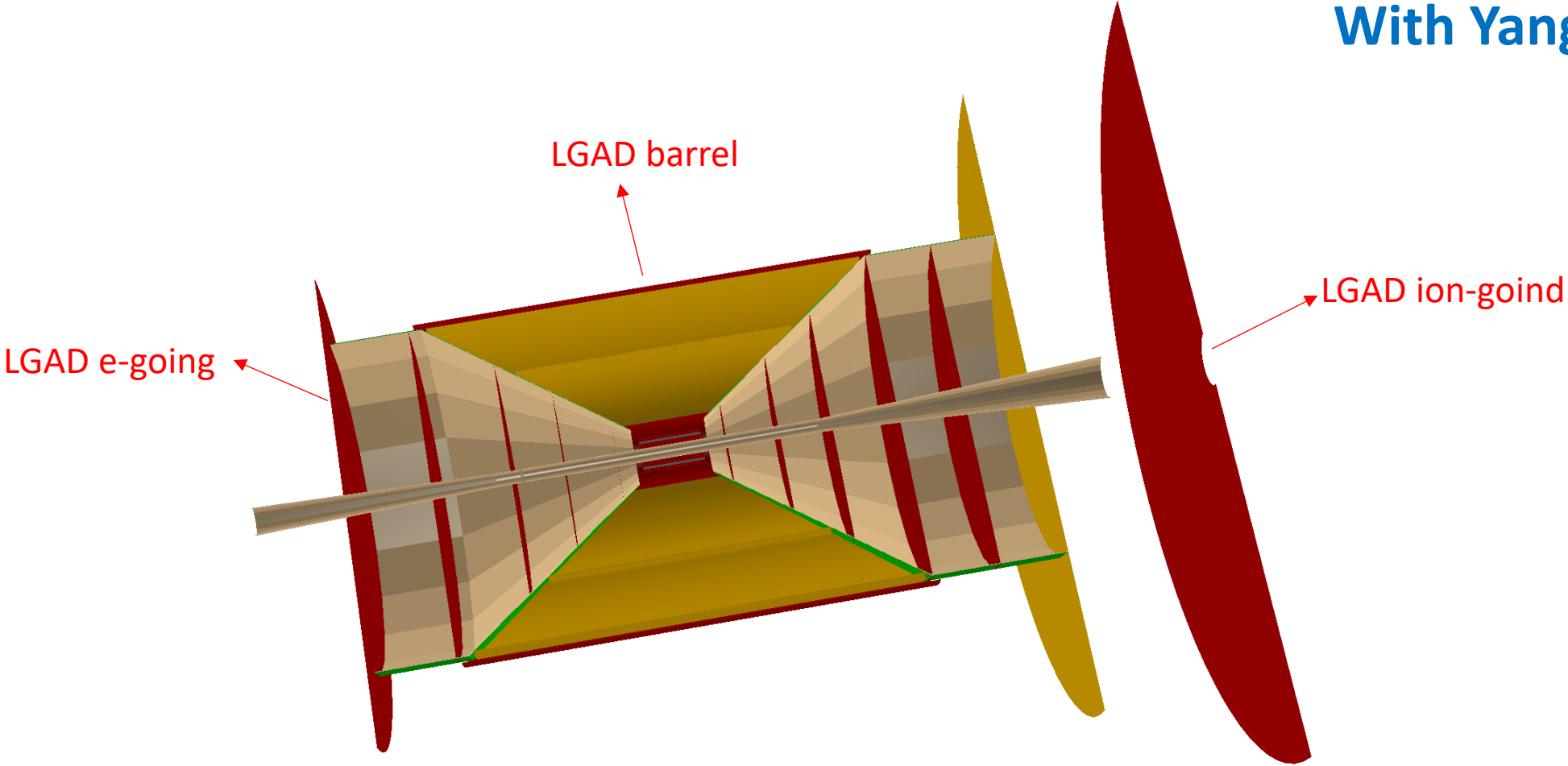
The radius of the middle two layers are optimized by a 2D scanning for $\mathbf{p} = 10\text{GeV}$:

1. Scan r_1 from A \rightarrow B
2. For each r_1 position, scan r_2 from C \rightarrow B

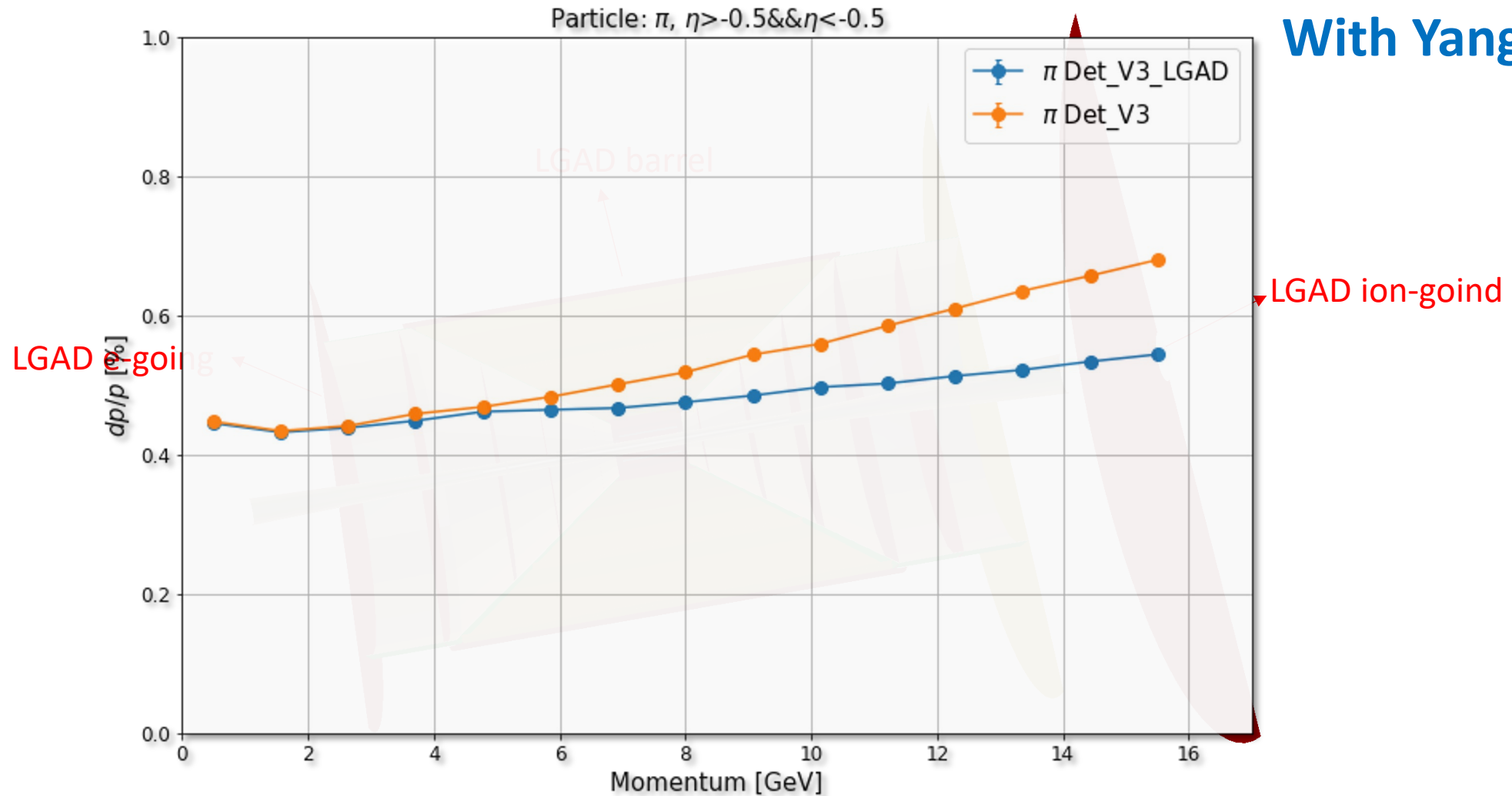


Tracking with TOF

With Yang shuai



Tracking with TOF



With Yang shuai

CDR preparation

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Summary and outlook

Summary:

- A conceptual design for EicC tracker, which consists of MAPS and MPGD, is proposed
- The performance is studied with GEANT4 simulation
- CDR preparation is almostly done

Outlook:

- Need to figure out the physics requirement according to FAST simulation
- Optimize the geometry further for both barrel and endcap region
- Probably try new design: e.g. Silicon pixel + TPC

Thank you !

Backup